ISP1507A1; ISP1507B1

ULPI Hi-Speed USB OTG transceiver

1. General description

The ISP1507A1; ISP1507B1 (ISP1507x1) is a Universal Serial Bus (USB) On-The-Go (OTG) transceiver that is fully compliant with *Universal Serial Bus Specification Rev. 2.0*, *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.3*, and *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

The ISP1507x1 can transmit and receive USB data at high-speed (480 Mbit/s), full-speed (12 Mbit/s), and low-speed (1.5 Mbit/s), and provides a pin-optimized, physical layer front-end attachment to USB host, peripheral, and OTG devices.

It is ideal for use in portable electronic devices, such as mobile phones, digital still cameras, digital video cameras, Personal Digital Assistants (PDAs), and digital audio players. It allows USB Application-Specific Integrated Circuits (ASICs), Programmable Logic Devices (PLDs), and any system chip set to interface with the physical layer of the USB through a 12-pin interface.

The ISP1507x1 can interface to the link with digital I/O voltages in the range of 1.65 V to 3.6 V.

The ISP1507x1 is available in HVQFN32 package.

2. Features

- Fully complies with:
    - *Universal Serial Bus Specification Rev. 2.0*
    - *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.3*
    - *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*
- Interfaces to host, peripheral, and OTG device cores; optimized for portable devices or system ASICs with built-in USB OTG device core
- Complete Hi-Speed USB physical front-end solution that supports high-speed (480 Mbit/s), full-speed (12 Mbit/s), and low-speed (1.5 Mbit/s)
    - Integrated 45 $\Omega \pm 10\%$ high-speed termination resistors, 1.5 k$\Omega \pm 5\%$ full-speed device pull-up resistor, and 15 k$\Omega \pm 5\%$ host termination resistors
    - Integrated parallel-to-serial and serial-to-parallel converters to transmit and receive
    - USB clock and data recovery to receive USB data up to ± 500 ppm
    - Insertion of stuff bits during transmit and discarding of stuff bits during receive
    - Non-Return-to-Zero Inverted (NRZI) encoding and decoding
    - Supports bus reset, suspend, resume, and high-speed detection handshake (chirp)
- Complete USB OTG physical front-end that supports Host Negotiation Protocol (HNP) and Session Request Protocol (SRP)
    - Complete control over bus resistors

- ◆ Data line and V_{BUS} pulsing session request methods
- ◆ Integrated V_{BUS} voltage comparators
- ◆ Integrated cable (ID) detector
- Highly optimized ULPI-compliant
  - ◆ 60 MHz, 12-bit interface between the core and the transceiver
  - ◆ Supports 60 MHz output clock configuration
  - ◆ Integrated Phase-Locked Loop (PLL) supporting one crystal or clock frequency: 19.2 MHz (ISP1507A1) and 26 MHz (ISP1507B1)
  - ◆ Fully programmable ULPI-compliant register set
  - ◆ Internal Power-On Reset (POR) circuit
- Flexible system integration and very low current consumption, optimized for portable devices
  - ◆ Power-supply input range is 3.0 V to 3.6 V
  - ◆ Internal voltage regulator supplies 3.3 V and 1.8 V
  - ◆ Supports external V_{BUS} charge pump or 5 V V_{BUS} switch:

    External V_{BUS} source is controlled using the PSW_N pin; open-drain PSW_N allows per-port or ganged power control

    Digital FAULT input to monitor the external V_{BUS} supply status
  - ◆ Pin CHIP_SELECT_N 3-states the ULPI interface, allowing bus reuse for other applications
  - ◆ Supports wide range interfacing I/O voltage of 1.65 V to 3.6 V; separate I/O voltage pins minimize crosstalk
  - ◆ Typical operating current of 11 mA to 48 mA, depending on the USB speed and bus utilization
  - ◆ Typical suspend current of 35 μA
- Full industrial grade operating temperature range from −40 °C to +85 °C
- 4 kV ElectroStatic Discharge (ESD) protection at pins DP, DM, ID, V_{BUS}, and GND
- Available in a small HVQFN32 (5 mm × 5 mm) Restriction of Hazardous Substances (RoHS) compliant, halogen-free and lead-free package

3. Applications

- Digital still camera
- Digital TV
- Digital Video Disc (DVD) recorder
- External storage device, for example:
  - ◆ Magneto-Optical (MO) drive
  - ◆ Optical drive: CD-ROM, CD-RW, DVD
  - ◆ Zip drive
- Mobile phone
- MP3 player
- PDA
- Printer
- Scanner
- Set-Top Box (STB)

■ Video camera

4. Ordering information

Table 1.   Ordering information

Commercial product code	Crystal or clock frequency	Package description	Packing	Minimum sellable quantity
ISP1507A1HNTM	19.2 MHz	HVQFN32; 32 terminals; body 5 × 5 × 0.85 mm	13 inch tape and reel non-dry pack	6000 pieces
ISP1507B1HNTM	26 MHz	HVQFN32; 32 terminals; body 5 × 5 × 0.85 mm	13 inch tape and reel non-dry pack	6000 pieces

5. Marking

Table 2.   Marking codes

Commercial product code	Marking code[1]
ISP1507A1HNTM	first line: ISP1507
	second line: A1HN
ISP1507B1HNTM	first line: ISP1507
	second line: B1HN

[1]   The package marking is the first and second lines of text on the IC package, and can be used for IC identification.

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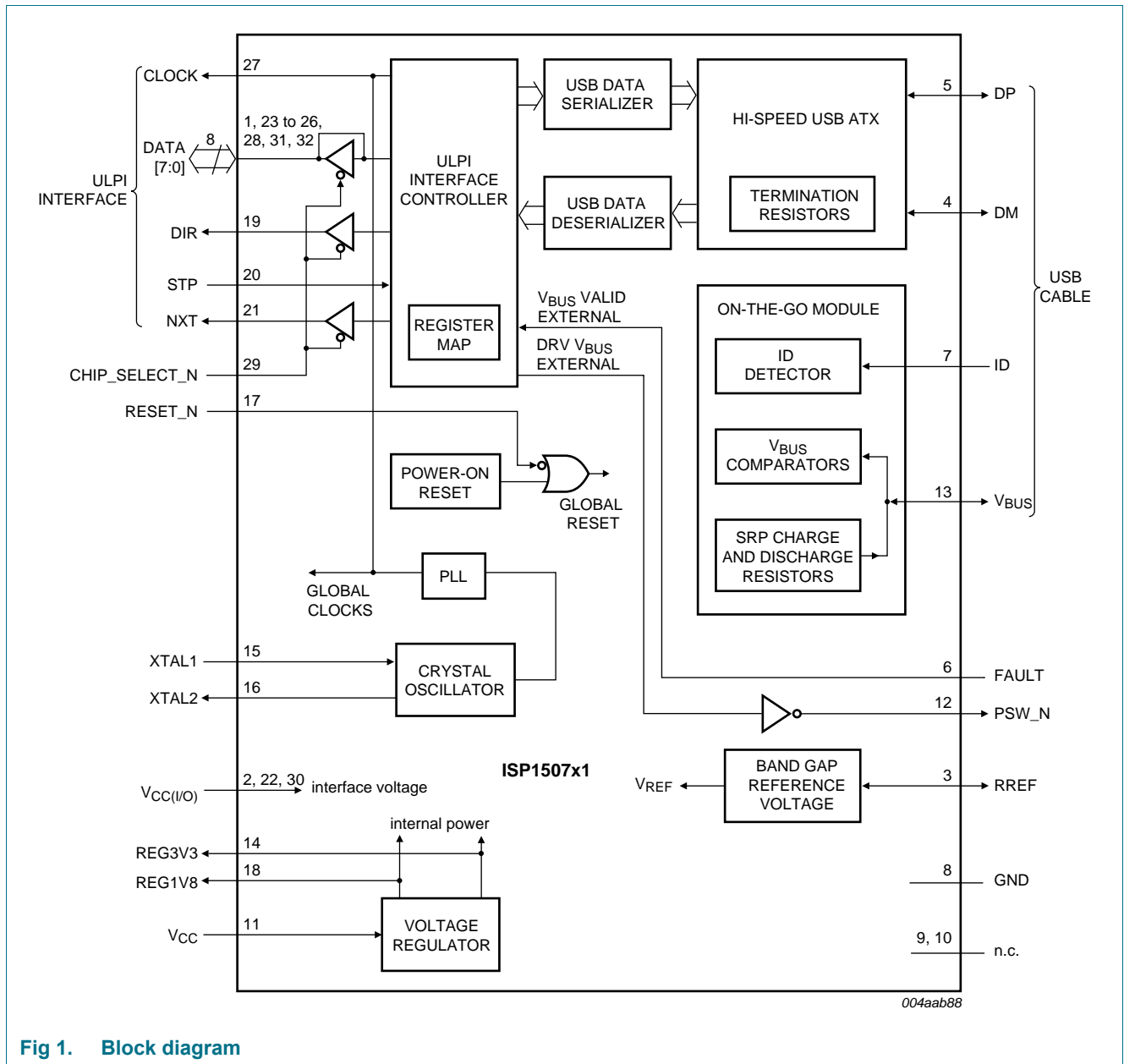# 6. Block diagram

Fig 1.   Block diagram
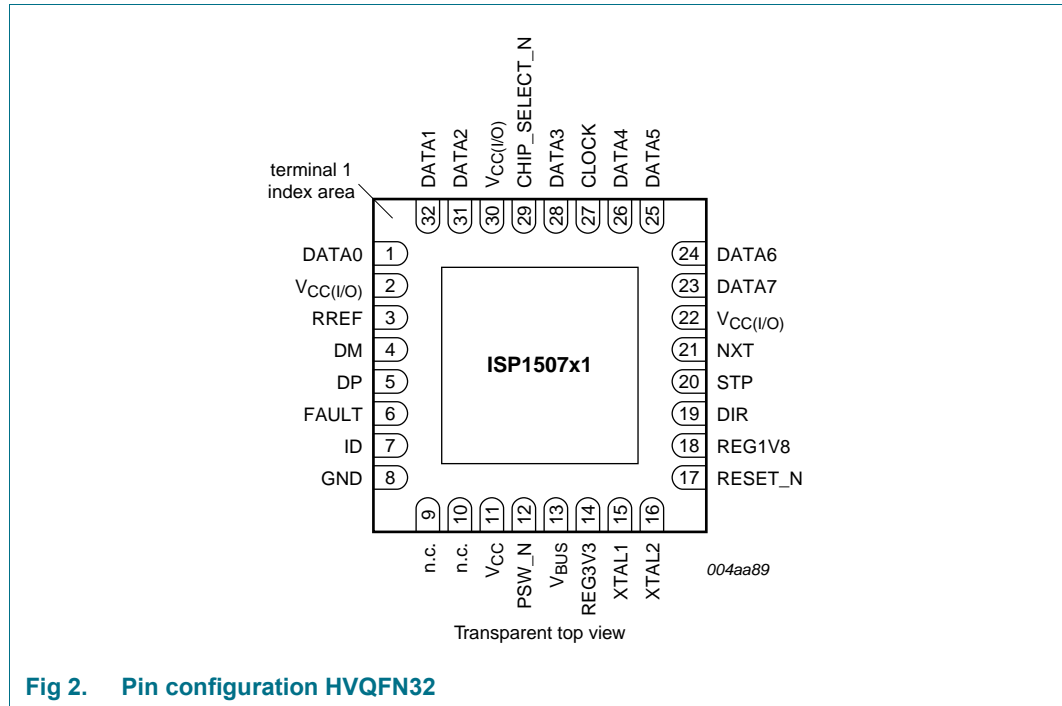
7. Pinning information

7.1 Pinning

Fig 2.   Pin configuration HVQFN32

7.2 Pin description

Table 3.   Pin description

Symbol[1][2]	Pin	Type[3]	Description[4]
DATA0	1	I/O	pin 0 of the bidirectional ULPI data bus
			slew-rate controlled output (1 ns); plain input; programmable pull down
$V_{CC(I/O)}$	2	P	I/O supply rail
RREF	3	AI/O	resistor reference
DM	4	AI/O	data minus (D−) pin of the USB cable
DP	5	AI/O	data plus (D+) pin of the USB cable
FAULT	6	I	input pin for the external V_{BUS} digital overcurrent or fault detector signal
			If this pin is not in use, connect it to GND.
			plain input; 5 V tolerant
ID	7	I	identification (ID) pin of the micro-USB cable
			If this pin is not used, it is recommended to connect to REG3V3.
			plain input; TTL level
GND	8	P	ground supply
n.c.	9	-	not connected; leave this pin open
n.c.	10	-	not connected; leave this pin open

Table 3.   **Pin description** *…continued*

Symbol[1][2]	Pin	Type[3]	Description[4]
V_{CC}	11	P	input supply voltage or battery source
PSW_N	12	OD	active-LOW external V_{BUS} power switch or external charge pump enable open-drain; 5 V tolerant
V_{BUS}	13	AI/O	V_{BUS} pin of the USB cable 5 V tolerant
REG3V3	14	P	3.3 V regulator output; requires parallel 0.1 μF and 4.7 μF capacitors; internally powers ATX and other analog circuits; must not be used to power external circuits
XTAL1	15	AI	crystal oscillator or clock input
XTAL2	16	AO	crystal oscillator output
RESET_N	17	I	active-LOW asynchronous reset input plain input
REG1V8	18	P	1.8 V regulator output; requires parallel 0.1 μF and 4.7 μF capacitors; internally powers the digital core; must not be used to power external circuits
DIR	19	O	ULPI direction signal slew-rate controlled output (1 ns)
STP	20	I	ULPI stop signal plain input; programmable pull up
NXT	21	O	ULPI next signal slew-rate controlled output (1 ns)
$V_{CC(I/O)}$	22	P	I/O supply rail
DATA7	23	I/O	pin 7 of the bidirectional ULPI data bus slew-rate controlled output (1 ns); plain input; programmable pull down
DATA6	24	I/O	pin 6 of the bidirectional ULPI data bus slew-rate controlled output (1 ns); plain input; programmable pull down
DATA5	25	I/O	pin 5 of the bidirectional ULPI data bus slew-rate controlled output (1 ns); plain input; programmable pull down
DATA4	26	I/O	pin 4 of the bidirectional ULPI data bus slew-rate controlled output (1 ns); plain input; programmable pull down
CLOCK	27	O	60 MHz clock output slew-rate controlled output (1 ns); plain input
DATA3	28	I/O	pin 3 of the bidirectional ULPI data bus slew-rate controlled output (1 ns); plain input; programmable pull down
CHIP_SELECT_N	29	I	active-LOW chip select If this pin is not in use, connect it to GND. plain input
$V_{CC(I/O)}$	30	P	I/O supply rail

Table 3.   **Pin description** …*continued*

Symbol[1][2]	Pin	Type[3]	Description[4]
DATA2	31	I/O	pin 2 of the bidirectional ULPI data bus
			slew-rate controlled output (1 ns); plain input; programmable pull down
DATA1	32	I/O	pin 1 of the bidirectional ULPI data bus
			slew-rate controlled output (1 ns); plain input; programmable pull down
GND	die pad	P	ground supply; down bonded to the exposed die pad (heat sink); to be connected to the PCB ground

[1]   Symbol names ending with underscore N, for example, NAME_N, indicate active-LOW signals.

[2]   For details on external components required on each pin, see list of materials and application diagrams in Section 17.

[3]   I = input; O = output; I/O = digital input/output; OD = open-drain output; AI = analog input; AO = analog output; AI/O = analog input/output; P = power or ground pin.

[4]   A detailed description of these pins can be found in Section 8.9.

8. Functional description

8.1 ULPI interface controller

The ISP1507x1 provides a 12-pin interface that is compliant with *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*. This interface must be connected to the USB link.

The ULPI interface controller provides the following functions:

- ULPI-compliant interface and register set
- Allows full control over the USB peripheral, host, and OTG functionality
- Parses USB transmit and receive data
- Prioritizes USB receive data, USB transmit data, interrupts, and register operations
- Low-power mode
- V_{BUS} monitoring, charging, and discharging
- 6-pin serial mode and 3-pin serial mode
- Generates RXCMDs; status updates
- Maskable interrupts
- Control over the ULPI bus state, allowing pins to 3-state or attach active weak pull-down resistors

For more information on the ULPI protocol, see Section 10.

8.2 USB data serializer and deserializer

The USB data serializer prepares data to transmit on the USB bus. To transmit data, the USB link sends a transmit command and data on the ULPI bus. The serializer performs parallel-to-serial conversion, bit stuffing, and NRZI encoding. For packets with a PID, the serializer adds a SYNC pattern to the start of the packet, and an EOP pattern to the end of the packet. When the serializer is busy and cannot accept any more data, the ULPI interface controller deasserts NXT.

The USB data deserializer decodes data received from the USB bus. When data is received, the deserializer strips the SYNC and EOP patterns, and then performs serial-to-parallel conversion, NRZI decoding, and discarding of stuff bits on the data payload. The ULPI interface controller sends data to the USB link by asserting DIR, and then asserting NXT whenever a byte is ready. The deserializer also detects various receive errors, including bit stuff errors, elasticity buffer underrun or overrun, and byte-alignment errors.

8.3 Hi-Speed USB (USB 2.0) ATX

The Hi-Speed USB ATX block is an analog front-end containing the circuitry needed to transmit, receive, and terminate the USB bus in high-speed, full-speed, and low-speed, for USB peripheral, host, and OTG implementations. The following circuitry is included:

- Differential drivers to transmit data at high-speed, full-speed, and low-speed
- Differential and single-ended receivers to receive data at high-speed, full-speed, and low-speed

- Squelch circuit to detect high-speed bus activity
- High-speed disconnect detector
- 45 Ω high-speed bus terminations on DP and DM for peripheral and host modes
- 1.5 kΩ pull-up resistor on DP for full-speed peripheral mode
- 15 kΩ bus terminations on DP and DM for host and OTG modes

For details on controlling resistor settings, see Table 8.

8.4 Voltage regulator

The ISP1507x1 contains a built-in voltage regulator that conditions the V_{CC} supply for use inside the ISP1507x1. The voltage regulator:

- Supports input supply range of 3.0 V < V_{CC} < 3.6 V
- Supplies internal circuitry with 1.8 V and 3.3 V

Remark: The REG1V8 and REG3V3 pins require external decoupling capacitors. For details, see Section 17.

8.5 Crystal oscillator and PLL

The ISP1507x1 has a built-in crystal oscillator and a Phase-Locked Loop (PLL) for clock generation.

The crystal oscillator takes a sine-wave input from an external crystal on the XTAL1 pin, and converts it to a square wave clock for internal use. Alternatively, a square wave clock of the same frequency can also be directly driven into the XTAL1 pin. Using an existing square wave clock can save the cost of a crystal and also reduce the board size.

The PLL takes the square wave clock from the crystal oscillator, and multiplies or divides it into various frequencies for internal use.

The PLL produces the following frequencies, irrespective of the clock source:

- 60 MHz clock for the ULPI interface controller
- 1.5 MHz for the low-speed USB data
- 12 MHz for the full-speed USB data
- 480 MHz for the high-speed USB data
- Other internal frequencies for data conversion and data recovery

8.6 OTG module

This module contains several sub-blocks that provide all the functionality required by the USB OTG specification. Specifically, it provides the following circuits:

- The ID detector to sense the ID pin of the micro-USB cable. The ID pin dictates which device is initially configured as the host and which as the peripheral.
- V_{BUS} comparators to determine the V_{BUS} voltage level. This is required for the V_{BUS} detection, SRP, and HNP.
- Resistors to temporarily charge and discharge V_{BUS}. This is required for SRP.

8.6.1 ID detector

The ID detector detects which end of the micro-USB cable is plugged in. The detector must first be enabled by setting the ID_PULLUP register bit to logic 1. If the ISP1507x1 senses a value on ID that is different from the previously reported value, an RXCMD status update will be sent to the USB link, or an interrupt will be asserted.

- If the micro-B end of the cable is plugged in, the ISP1507x1 will report that ID_GND is logic 1. The USB link must change to peripheral mode.

- If the micro-A end of the cable is plugged in, the ISP1507x1 will report that ID_GND is logic 0. The USB link must change to host mode.

8.6.2 V_{BUS} comparators

The ISP1507x1 provides three comparators, V_{BUS} valid comparator, session valid comparator, and session end comparator, to detect the V_{BUS} voltage level.

8.6.2.1 V_{BUS} valid comparator

This comparator is used by hosts and A-devices to determine whether the voltage on V_{BUS} is at a valid level for operation. The ISP1507x1 minimum threshold for the V_{BUS} valid comparator is 4.4 V. Any voltage on V_{BUS} below this threshold is considered invalid. During power-up, it is expected that the comparator output will be ignored.

8.6.2.2 Session valid comparator

The session valid comparator is a TTL-level input that determines when V_{BUS} is high enough for a session to start. Peripherals, A-devices, and B-devices use this comparator to detect when a session is started. The A-device also uses this comparator to determine when a session is completed. The session valid threshold of the ISP1507x1 is $V_{B\_SESS\_VLD}$, with a hysteresis of $V_{hys(B\_SESS\_VLD)}$.

8.6.2.3 Session end comparator

The ISP1507x1 session end comparator determines when V_{BUS} is below the B-device session end threshold. The B-device uses this threshold to determine when a session has ended. The session end threshold of the ISP1507x1 is $V_{B\_SESS\_END}$.

8.6.3 SRP charge and discharge resistors

The ISP1507x1 provides on-chip resistors for short-term charging and discharging of V_{BUS}. These are used by the B-device to request a session, prompting the A-device to restore the V_{BUS} power. First, the B-device makes sure that V_{BUS} is fully discharged from the previous session by setting the DISCHRG_VBUS register bit to logic 1 and waiting for SESS_END to be logic 1. Then the B-device charges V_{BUS} by setting the CHRG_VBUS register bit to logic 1. The A-device sees that V_{BUS} is charged above the session valid threshold and starts a session by turning on the V_{BUS} power.

8.7 Band gap reference voltage

The band gap circuit provides a stable internal voltage reference to bias the analog circuitry. The band gap requires an accurate external reference, R_{RREF}, resistor connected between the RREF pin and GND. For details, see Section 17.

8.8 Power-On Reset (POR)

The ISP1507x1 has an internal power-on reset circuit that resets all internal logic on power-up. The ULPI interface is also reset on power-up.

Remark: When CLOCK starts toggling after power-up, the USB link must issue a reset command over the ULPI bus to ensure correct operation of the ISP1507x1.

8.9 Detailed description of pins

8.9.1 DATA[7:0]

The ISP1507x1 is a Physical layer (PHY) containing a USB transceiver. DATA[7:0] is the bidirectional data bus. The USB link must drive DATA[7:0] to LOW when the ULPI bus is idle. When the link has data to transmit to the PHY, it drives a nonzero value.

The data bus can be reconfigured to carry various data types, as given in Section 9 and Section 10.

The DATA[7:0] pins can be 3-stated by driving pin CHIP_SELECT_N to HIGH. Weak pull-down resistors are incorporated into the DATA[7:0] pins as part of the interface protect feature. For details, see Section 10.3.1.

8.9.2 $V_{CC(I/O)}$

The input power pin that sets the I/O voltage level. For details, see Section 13, Section 14, and Section 17. $V_{CC(I/O)}$ provides power to on-chip pads of the following pins:

- CHIP_SELECT_N
- CLOCK
- DATA[7:0]
- DIR
- NXT
- RESET_N
- STP

8.9.3 RREF

Resistor reference analog I/O pin. A resistor, R_{RREF}, must be connected between RREF and GND, as shown in Section 17. This provides an accurate voltage reference that biases internal analog circuitry. Less accurate resistors cannot be used and will render the ISP1507x1 unusable.

8.9.4 DP and DM

The DP (data plus) and DM (data minus) are USB differential data pins. These must be connected to the D+ and D− pins of the USB receptacle.

8.9.5 FAULT

If an external V_{BUS} overcurrent or fault circuit is used, the output fault indicator of that circuit can be connected to the ISP1507x1 FAULT input pin. The ISP1507x1 will inform the link of V_{BUS} fault events by sending RXCMDs on the ULPI bus. To use the FAULT pin, the link must:

- Set the USE_EXT_VBUS_IND register bit to logic 1.
- Set the polarity of the external fault signal using the IND_COMPL register bit.
- Set the IND_PASSTHRU register bit to logic 1.

If the FAULT pin is not used, it is recommended to connect to GND.

8.9.6 ID

For OTG implementations, the ID (identification) pin is connected to the ID pin of the micro-USB receptacle. As defined in *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.3*, the ID pin dictates the initial role of the link. If ID is detected as HIGH, the link must assume the role of a peripheral. If ID is detected as LOW, the link must assume a host role. Roles can be swapped at a later time by using HNP.

If the ISP1507x1 is not used as an OTG PHY, but as a standard USB host or peripheral PHY, the ID pin must be connected to REG3V3.

8.9.7 V_{CC}

V_{CC} is the main input supply voltage for the ISP1507x1. Decoupling capacitors are recommended. For details, see Section 17.

8.9.8 PSW_N

PSW_N is an active-LOW, open-drain output pin. This pin can be connected to an active-LOW, external V_{BUS} switch or charge pump enable circuit to control the external V_{BUS} power source. An external pull-up resistor, R_{pullup}, is required when PSW_N is used. This pin is open-drain, allowing ganged-mode power control for multiple USB ports. For application details, see Section 17.

If the link is in host mode, it can enable the external V_{BUS} power source by setting the DRV_VBUS_EXT bit in the OTG_CTRL register (see Section 11.1.4) to logic 1. The ISP1507x1 will drive PSW_N to LOW to enable the external V_{BUS} power source. If the link detects an overcurrent condition (the V_{BUS} state in RXCMD is not 11b), it must disable the external V_{BUS} power source by setting DRV_VBUS_EXT to logic 0.

8.9.9 V_{BUS}

This pin acts as an input to V_{BUS} comparators, and also charges and discharges V_{BUS} for SRP.

The V_{BUS} pin requires a capacitive load as shown in Section 17.

To prevent electrical overstress, it is strongly recommended that you attach a series resistor on the V_{BUS} pin (R_{VBUS}). For details, see Section 17.

8.9.10 REG3V3 and REG1V8

Regulator output voltage. These supplies are used to power the ISP1507x1 internal digital and analog circuits, and must not be used to power external circuits.

For correct operation of the regulator, it is recommended that you connect REG3V3 and REG1V8 to decoupling capacitors. For examples, see Section 17.

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8.9.11 XTAL1 and XTAL2

XTAL1 is the crystal input, and XTAL2 is the crystal output. The allowed frequency on the XTAL1 pin depends on the ISP1507x1 product version.

If the link requires a 60 MHz clock from the ISP1507x1, then either a crystal must be attached, or a clock of the same frequency must be driven into XTAL1, with XTAL2 left floating.

If a crystal is attached, it requires external load capacitors to GND on each terminal of the crystal. For details, see Section 17.

If at any time the system wants to stop the clock on XTAL1, the link must first put the ISP1507x1 into low-power mode. The clock on XTAL1 must be restarted before low-power mode is exited.

8.9.12 RESET_N

An active-LOW asynchronous reset pin that resets all circuits in the ISP1507x1. The ISP1507x1 contains an internal power-on reset circuit, and therefore using the RESET_N pin is optional. If RESET_N is not used, it must be connected to $V_{CC(I/O)}$.

For details on using RESET_N, see Section 10.3.2.

8.9.13 DIR

ULPI direction output pin. Controls the direction of the data bus. By default, the ISP1507x1 holds DIR at LOW, causing the data bus to be an input. When DIR is LOW, the ISP1507x1 listens for data from the link. The ISP1507x1 pulls DIR to HIGH only when it has data to send to the link, which is for one of two reasons:

- To send USB receive data, RXCMD status updates, and register read data to the link.
- To block the link from driving the data bus during power-up, reset, and low-power (suspend) mode.

The DIR pin can also be 3-stated by driving CHIP_SELECT_N to HIGH.

For details on DIR usage, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

8.9.14 STP

ULPI stop input pin. The link must assert STP to signal the end of a USB transmit packet or a register write operation. When DIR is asserted, the link can optionally assert STP to abort the ISP1507x1, causing it to deassert DIR in the next clock cycle. A weak pull-up resistor is incorporated into the STP pin as part of the interface protect feature. For details, see Section 10.3.1.

The STP input will be ignored when CHIP_SELECT_N is driven to HIGH.

For details on STP usage, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

8.9.15 NXT

ULPI next data output pin. The ISP1507x1 holds NXT at LOW, by default. When DIR is LOW and the link is sending data to the ISP1507x1, NXT will be asserted to notify the link to provide the next data byte. When DIR is at HIGH and the ISP1507x1 is sending data to the link, NXT will be asserted to notify the link that another valid byte is on the bus. NXT is not used for register read data or the RXCMD status update.

The NXT pin can also be 3-stated by driving CHIP_SELECT_N to HIGH.

For details on NXT usage, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

8.9.16 CLOCK

A 60 MHz interface clock to synchronize the ULPI bus. The ISP1507x1 provides two clocking options:

- A crystal attached between the XTAL1 and XTAL2 pins.
- A clock driven into the XTAL1 pin, with the XTAL2 pin left floating.

For details on CLOCK usage, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

8.9.17 CHIP_SELECT_N

Active-LOW chip select pin. If CHIP_SELECT_N is not used, it must be connected to GND. For more information on using CHIP_SELECT_N, see Section 10.3.3.

8.9.18 GND

Global ground signal. To ensure correct operation of the ISP1507x1, GND must be soldered to the cleanest ground available.

9. Modes of operation

9.1 ULPI modes

The ISP1507x1 ULPI bus can be programmed to operate in four modes. Each mode reconfigures the signals on the data bus as described in the following subsections. Setting more than one mode will lead to undefined behavior.

9.1.1 Synchronous mode

This is default mode. At power-up, and when CLOCK is stable, the ISP1507x1 will enter synchronous mode. The link must synchronize all ULPI signals to CLOCK, meeting the set-up time and the hold time as defined in Section 16. A description of the ULPI pin behavior in synchronous mode is given in Table 4.

This mode is used by the link to perform the following tasks:

- High-speed detection handshake (chirp)
- Transmit and receive USB packets
- Read and write to registers
- Receive USB status updates (RXCMDs)

For more information on various synchronous mode protocols, see Section 10.

Table 4.   ULPI signal description

Signal name	Direction on ISP1507x1	Signal description
CLOCK	O	**60 MHz interface clock**. If a crystal is attached or a clock is driven into the XTAL1 pin, the ISP1507x1 will drive a 60 MHz output clock.
DATA[7:0]	I/O	**8-bit data bus**. In synchronous mode, the link drives DATA[7:0] to LOW by default. The link initiates transfers by sending a nonzero data pattern called TXCMD (transmit command). In synchronous mode, the direction of DATA[7:0] is controlled by DIR. Contents of DATA[7:0] lines must be ignored for exactly one clock cycle whenever DIR changes value. This is called the turnaround cycle.
		Data lines have fixed direction and different meaning in low-power and serial modes.

Table 4. **ULPI signal description** *…continued*

Signal name	Direction on ISP1507x1	Signal description
DIR	O	**Direction**: Controls the direction of data bus DATA[7:0]. In synchronous mode, the ISP1507x1 drives DIR to LOW by default, making the data bus an input so that the ISP1507x1 can listen for TXCMDs from the link. The ISP1507x1 drives DIR to HIGH only when it has data for the link. When DIR and NXT are HIGH, the byte on the data bus contains decoded USB data. When DIR is HIGH and NXT is LOW, the byte contains status information called RXCMD (receive command). The only exception to this rule is when the PHY returns register read data, where NXT is also LOW, replacing the usual RXCMD byte. Every change in DIR causes a turnaround cycle on the data bus, during which DATA[7:0] is not valid and must be ignored by the link. DIR is always asserted during low-power and serial modes.
STP	I	**Stop**: In synchronous mode, the link drives STP to HIGH for one cycle after the last byte of data is sent to the ISP1507x1. The link can optionally assert STP to force DIR to be deasserted. In low-power and serial modes, the link holds STP at HIGH to wake up the ISP1507x1, causing the ULPI bus to return to synchronous mode.
NXT	O	**Next**: In synchronous mode, the ISP1507x1 drives NXT to HIGH to throttle data. If DIR is LOW, the ISP1507x1 asserts NXT to notify the link to place the next data byte on DATA[7:0] in the following clock cycle. If DIR is HIGH, the ISP1507x1 asserts NXT to notify the link that a valid USB data byte is on DATA[7:0] in the current cycle. The ISP1507x1 always drives an RXCMD when DIR is HIGH and NXT is LOW, unless register read data is to be returned to the link in the current cycle. NXT is not used in low-power or serial mode.

9.1.2 Low-power mode

When the USB is idle, the link can place the ISP1507x1 into low-power mode (also called suspend mode). In low-power mode, the data bus definition changes to that shown in Table 5. To enter low-power mode, the link sets the SUSPENDM bit in the FUNC_CTRL register (see Section 11.1.2) to logic 0. To exit low-power mode, the link asserts the STP signal. The ISP1507x1 will draw only suspend current from the V_{CC} supply (see Table 46).

During low-power mode, the clock on XTAL1 may be stopped. The clock must be started again before asserting STP to exit low-power mode. After exiting low-power mode, the ISP1507x1 will send an RXCMD to the link if a change was detected in any interrupt source, and the change still exists. An RXCMD may not be sent if the interrupt condition is removed before exiting.

For more information on low-power mode enter and exit protocols, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

Table 5. **Signal mapping during low-power mode**

Signal	Maps to	Direction[1]	Description
LINESTATE0	DATA0	O	combinatorial LINESTATE0 directly driven by the analog receiver
LINESTATE1	DATA1	O	combinatorial LINESTATE1 directly driven by the analog receiver

Table 5.   Signal mapping during low-power mode *…continued*

Signal	Maps to	Direction[1]	Description
Reserved	DATA2	O	reserved; the ISP1507x1 will drive this pin to LOW
INT	DATA3	O	active-HIGH interrupt indication; will be asserted whenever any unmasked interrupt occurs
Reserved	DATA[7:4]	O	reserved; the ISP1507x1 will drive these pins to LOW

[1]   O = output.

9.1.3   6-pin full-speed or low-speed serial mode

If the link requires a 6-pin serial interface to transmit and receive full-speed or low-speed USB data, it can set the ISP1507x1 to 6-pin serial mode. In 6-pin serial mode, the DATA[7:0] bus definition changes to that shown in Table 6. To enter 6-pin serial mode, the link sets the 6PIN_FSLS_SERIAL bit in the INTF_CTRL register (see Section 11.1.3) to logic 1. To exit 6-pin serial mode, the link asserts STP. This is provided primarily for links that contain legacy full-speed or low-speed functionality, providing a more cost-effective upgrade path to high-speed. An interrupt pin is also provided to inform the link of USB events. If the link requires CLOCK to be running during 6-pin serial mode, the CLOCK_SUSPENDM register bit must be set to logic 1.

For more information on 6-pin serial mode enter and exit protocols, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1.*

Table 6.   Signal mapping for 6-pin serial mode

Signal	Maps to	Direction[1]	Description
TX_ENABLE	DATA0	I	active-HIGH transmit enable
TX_DAT	DATA1	I	transmit differential data on DP and DM
TX_SE0	DATA2	I	transmit single-ended zero on DP and DM
INT	DATA3	O	active-HIGH interrupt indication; will be asserted whenever any unmasked interrupt occurs
RX_DP	DATA4	O	single-ended receive data from DP
RX_DM	DATA5	O	single-ended receive data from DM
RX_RCV	DATA6	O	differential receive data from DP and DM
Reserved	DATA7	O	reserved; the ISP1507x1 will drive this pin to LOW

[1]   I = input; O = output.

9.1.4   3-pin full-speed or low-speed serial mode

If the link requires a 3-pin serial interface to transmit and receive full-speed or low-speed USB data, it can set the ISP1507x1 to 3-pin serial mode. In 3-pin serial mode, the data bus definition changes to that shown in Table 7. To enter 3-pin serial mode, the link sets the 3PIN_FSLS_SERIAL bit in the INTF_CTRL register (see Section 11.1.3) to logic 1. To exit 3-pin serial mode, the link asserts STP. This is primarily provided for links that contain legacy full-speed or low-speed functionality, providing a more cost-effective upgrade path to high-speed. An interrupt pin is also provided to inform the link of USB events. If the link requires CLOCK to be running during 3-pin serial mode, the CLOCK_SUSPENDM register bit must be set to logic 1.

For more information on 3-pin serial mode enter and exit protocols, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1.*

Table 7. Signal mapping for 3-pin serial mode

Signal	Maps to	Direction[1]	Description
TX_ENABLE	DATA0	I	active-HIGH transmit enable
DAT	DATA1	I/O	transmit differential data on DP and DM when TX_ENABLE is HIGH
			receive differential data from DP and DM when TX_ENABLE is LOW
SE0	DATA2	I/O	transmit single-ended zero on DP and DM when TX_ENABLE is HIGH
			receive single-ended zero from DP and DM when TX_ENABLE is LOW
INT	DATA3	O	active-HIGH interrupt indication; will be asserted whenever any unmasked interrupt occurs
Reserved	DATA[7:4]	O	reserved; the ISP1507x1 will drive these pins to LOW

[1] I = input; O = output; I/O = input/output.

9.2 USB and OTG state transitions

A Hi-Speed USB peripheral, host, or OTG device handles more than one electrical state as defined in *Universal Serial Bus Specification Rev. 2.0* and *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.3*. The ISP1507x1 accommodates various states through register bit settings of XCVRSELECT[1:0], TERMSELECT, OPMODE[1:0], DP_PULLDOWN, and DM_PULLDOWN.

Table 8 summarizes operating states. The values of register settings in Table 8 will force resistor settings as also given in Table 8. Resistor setting signals are defined as follows:

- RPU_DP_EN enables the 1.5 kΩ pull-up resistor on DP
- RPD_DP_EN enables the 15 kΩ pull-down resistor on DP
- RPD_DM_EN enables the 15 kΩ pull-down resistor on DM
- HSTERM_EN enables the 45 Ω termination resistors on DP and DM

It is up to the link to set the desired register settings.

Table 8. Operating states and their corresponding resistor settings

Signaling mode	Register settings					Internal resistor settings			
	XCVR SELECT [1:0]	TERM SELECT	OPMODE [1:0]	DP_PULL DOWN	DM_PULL DOWN	RPU_ DP_EN	RPD_ DP_EN	RPD_ DM_EN	HSTERM _EN
General settings									
3-state drivers	XXb	Xb	01b	Xb	Xb	0b	0b	0b	0b
Power-up or $V_{BUS} < V_{B\_SESS\_END}$	01b	0b	00b	1b	1b	0b	1b	1b	0b
Host settings									
Host chirp	00b	0b	10b	1b	1b	0b	1b	1b	1b
Host high-speed	00b	0b	00b	1b	1b	0b	1b	1b	1b
Host full-speed	X1b	1b	00b	1b	1b	0b	1b	1b	0b
Host high-speed or full-speed suspend	01b	1b	00b	1b	1b	0b	1b	1b	0b
Host high-speed or full-speed resume	01b	1b	10b	1b	1b	0b	1b	1b	0b
Host low-speed	10b	1b	00b	1b	1b	0b	1b	1b	0b

Table 8.   Operating states and their corresponding resistor settings *…continued*

Signaling mode	Register settings					Internal resistor settings			
	XCVR SELECT [1:0]	TERM SELECT	OPMODE [1:0]	DP_PULL DOWN	DM_PULL DOWN	RPU_ DP_EN	RPD_ DP_EN	RPD_ DM_EN	HSTERM _EN
Host low-speed suspend	10b	1b	00b	1b	1b	0b	1b	1b	0b
Host low-speed resume	10b	1b	10b	1b	1b	0b	1b	1b	0b
Host Test J or Test K	00b	0b	10b	1b	1b	0b	1b	1b	1b
Peripheral settings									
Peripheral chirp	00b	1b	10b	0b	0b	1b	0b	0b	0b
Peripheral high-speed	00b	0b	00b	0b	0b	0b	0b	0b	1b
Peripheral full-speed	01b	1b	00b	0b	0b	1b	0b	0b	0b
Peripheral high-speed or full-speed suspend	01b	1b	00b	0b	0b	1b	0b	0b	0b
Peripheral high-speed or full-speed resume	01b	1b	10b	0b	0b	1b	0b	0b	0b
Peripheral Test J or Test K	00b	0b	10b	0b	0b	0b	0b	0b	1b
OTG settings									
OTG device peripheral chirp	00b	1b	10b	0b	1b	1b	0b	1b	0b
OTG device peripheral high-speed	00b	0b	00b	0b	1b	0b	0b	1b	1b
OTG device peripheral full-speed	01b	1b	00b	0b	1b	1b	0b	1b	0b
OTG device peripheral high-speed and full-speed suspend	01b	1b	00b	0b	1b	1b	0b	1b	0b
OTG device peripheral high-speed and full-speed resume	01b	1b	10b	0b	1b	1b	0b	1b	0b
OTG device peripheral Test J or Test K	00b	0b	10b	0b	1b	0b	0b	1b	1b

10. Protocol description

The following subsections describe the protocol for using the ISP1507x1.

10.1 ULPI references

The ISP1507x1 provides a 12-pin ULPI interface to communicate with the link. It is highly recommended that you read *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1* and *UTMI+ Specification Rev. 1.0*.

10.2 Power-On Reset (POR)

An internal POR is generated when REG1V8 rises above $V_{POR(trip)}$, for at least $t_{w(REG1V8\_H)}$. The internal POR pulse will also be generated whenever REG1V8 drops below $V_{POR(trip)}$ for more than $t_{w(REG1V8\_L)}$, and then rises above $V_{POR(trip)}$ again. The voltage on REG1V8 is generated from V_{CC}.

To give a better view of the functionality, Figure 3 shows a possible curve of REG1V8. The internal POR starts with logic 0 at t0. At t1, the detector will see the passing of the trip level so that POR turns to logic 1 and a delay element will add another t_{PORP} before it drops to logic 0. If REG1V8 dips from t2 to t3 for > $t_{w(REG1V8\_L)}$, another POR pulse is generated. If the dip at t4 to t5 is too short, that is, < $t_{w(REG1V8\_L)}$, the internal POR pulse will not react and will remain LOW.
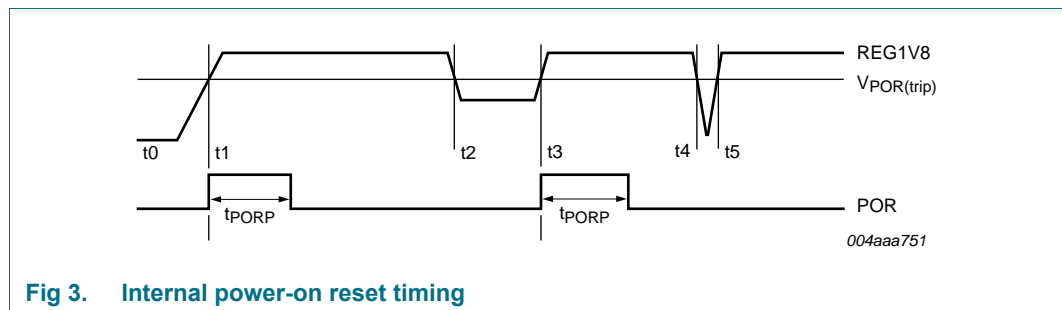
Fig 3.   Internal power-on reset timing

10.3 Power-up, reset, and bus idle sequence

Figure 4 shows a typical start-up sequence.

On power-up, the ISP1507x1 performs an internal power-on reset and asserts DIR to indicate to the link that the ULPI bus cannot be used. When the internal PLL is stable, the ISP1507x1 deasserts DIR. The power-up time depends on the V_{CC} supply rise time, the crystal start-up time, and PLL start-up time $t_{startup(o)(CLOCK)}$. Whenever DIR is asserted, the ISP1507x1 drives the NXT pin to LOW and drives DATA[7:0] with RXCMD values. When DIR is deasserted, the link must drive the data bus to a valid level. By default, the link must drive data to LOW. When the ISP1507x1 initially deasserts DIR on power-up, the link must ignore all RXCMDs until it resets the ISP1507x1. Before beginning USB packets, the link must set the RESET bit in the FUNC_CTRL register (see Section 11.1.2) to reset the ISP1507x1. After the RESET bit is set, the ISP1507x1 will assert DIR until the internal reset completes. The ISP1507x1 will automatically deassert DIR and clear the RESET bit when reset has completed. After every reset, an RXCMD is sent to the link to update USB status information. After this sequence, the ULPI bus is ready for use and the link can start USB operations.

If a crystal is attached or a clock is driven into the XTAL1 pin, the ISP1507x1 will drive a 60 MHz clock out from the CLOCK pin when DIR deasserts. This is shown as CLOCK in Figure 4.

The recommended power-up sequence for the link is as follows:

1. The link waits for t_{REGUP}, ignoring all the ULPI pin status.
2. The link may start to detect DIR status level. If DIR is detected as LOW for three clock cycles, the link may send a RESET command.

The ULPI interface is ready for use.

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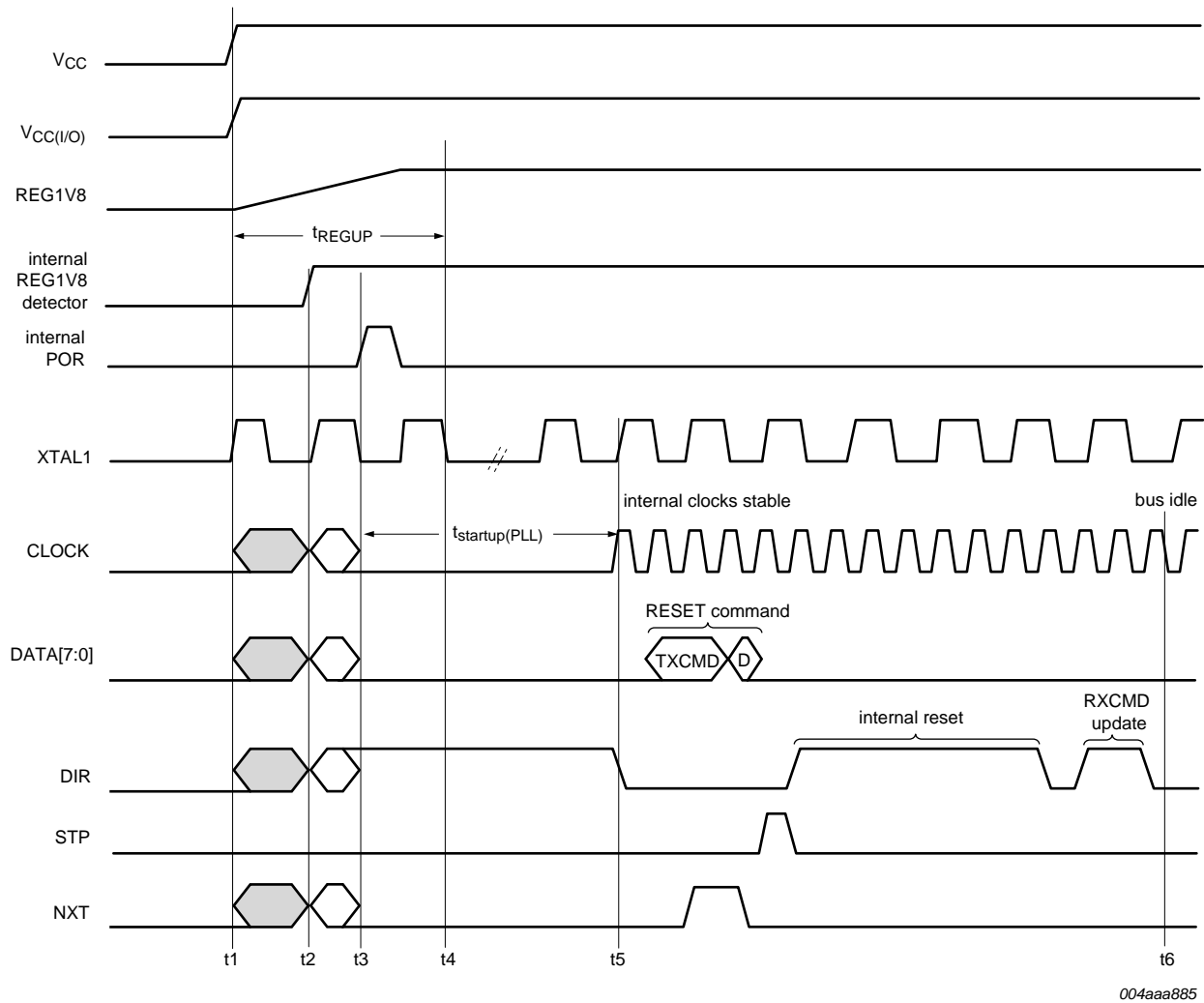
t1 = V_{CC} and $V_{CC(I/O)}$ are applied to the ISP1507x1. The ISP1507x1 regulator starts to turn on.

t2 = ULPI pads detect REG1V8 rising above the REG1V8 regulator threshold and are not in 3-state. These pads may drive either LOW or HIGH. It is recommended that the link ignores the ULPI pins status during t_{REGUP}.

t3 = The POR threshold is reached and a POR pulse is generated. After the POR pulse, ULPI pins are driven to a defined level. DIR is driven to HIGH and the other pins are driven to LOW.

t4 = The ISP1507x1 regulator is powered up and is stable.

t5 = The internal PLL is stabilized after $t_{startup(PLL)}$. If the 19.2 MHz or 26 MHz clock is started before POR, the internal PLL will be stabilized after $t_{startup(PLL)}$ from POR. The CLOCK pin starts to output 60 MHz. The DIR pin will transition from HIGH to LOW. The DIR pin will remain LOW before the link issues a RESET command to the ISP1507x1.

t6 = The power-up sequence is completed. The ULPI bus interface is ready for use.

Fig 4.   Power-up and reset sequence required before the ULPI bus is ready for use

10.3.1 Interface protection

By default, the ISP1507x1 enables a weak pull-up resistor on STP. If the STP pin is unexpectedly HIGH at any time, the ISP1507x1 will protect the ULPI interface by enabling weak pull-down resistors on DATA[7:0].

The interface protect feature prevents unwanted activity of the ISP1507x1 whenever the ULPI interface is not correctly driven by the link. For example, when the link powers up more slowly than the ISP1507x1.

The interface protect feature can be disabled by setting the INTF_PROT_DIS bit to logic 1.

10.3.2 Interface behavior with respect to RESET_N

The use of the RESET_N pin is optional. When RESET_N is asserted (LOW), the ISP1507x1 will assert DIR. All logic in the ISP1507x1 will be reset, including the analog circuitry and ULPI registers. During reset, the link must drive DATA[7:0] and STP to LOW; otherwise undefined behavior may result. When RESET_N is deasserted (HIGH), the DIR output will deassert (LOW) four or five clock cycles later. Figure 5 shows the ULPI interface behavior when RESET_N is asserted (LOW), and subsequently deasserted (HIGH). The behavior of Figure 5 applies only when CHIP_SELECT_N is asserted (LOW). If RESET_N is not used, it must be connected to $V_{CC(I/O)}$.
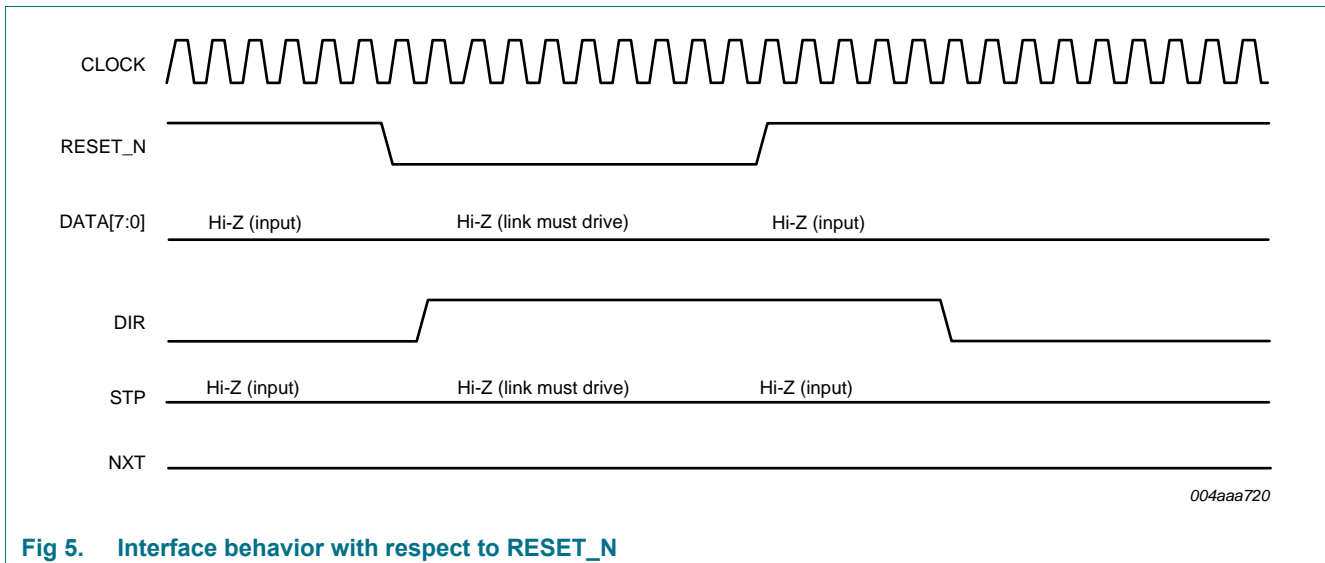
Fig 5.   Interface behavior with respect to RESET_N

10.3.3 Interface behavior with respect to CHIP_SELECT_N

At any time that CHIP_SELECT_N is HIGH, the ISP1507x1 will 3-state DATA[7:0], NXT, and DIR. STP input will be ignored. The link can reuse these pins for other purposes.

When CHIP_SELECT_N is LOW, ULPI output pins operate normally. During normal operation, the PLL is always powered, regardless of the level of CHIP_SELECT_N.

During power-up, if CHIP_SELECT_N is HIGH, the PLL is not powered up to reduce power consumption. During power-up, if CHIP_SELECT_N is LOW, the PLL is powered and the ISP1507x1 operates normally.

If CHIP_SELECT_N is HIGH:

- The DATA[7:0], NXT, and DIR pins are 3-stated and ignored.
- If the ISP1507x1 was previously in synchronous mode, the STP pin is ignored. If the ISP1507x1 was previously in serial or suspend mode, STP is used to exit.
- The pull-down resistors on DATA[7:0] are disabled.

- The ULPI controller is forced into an idle state and any ULPI command is ignored.
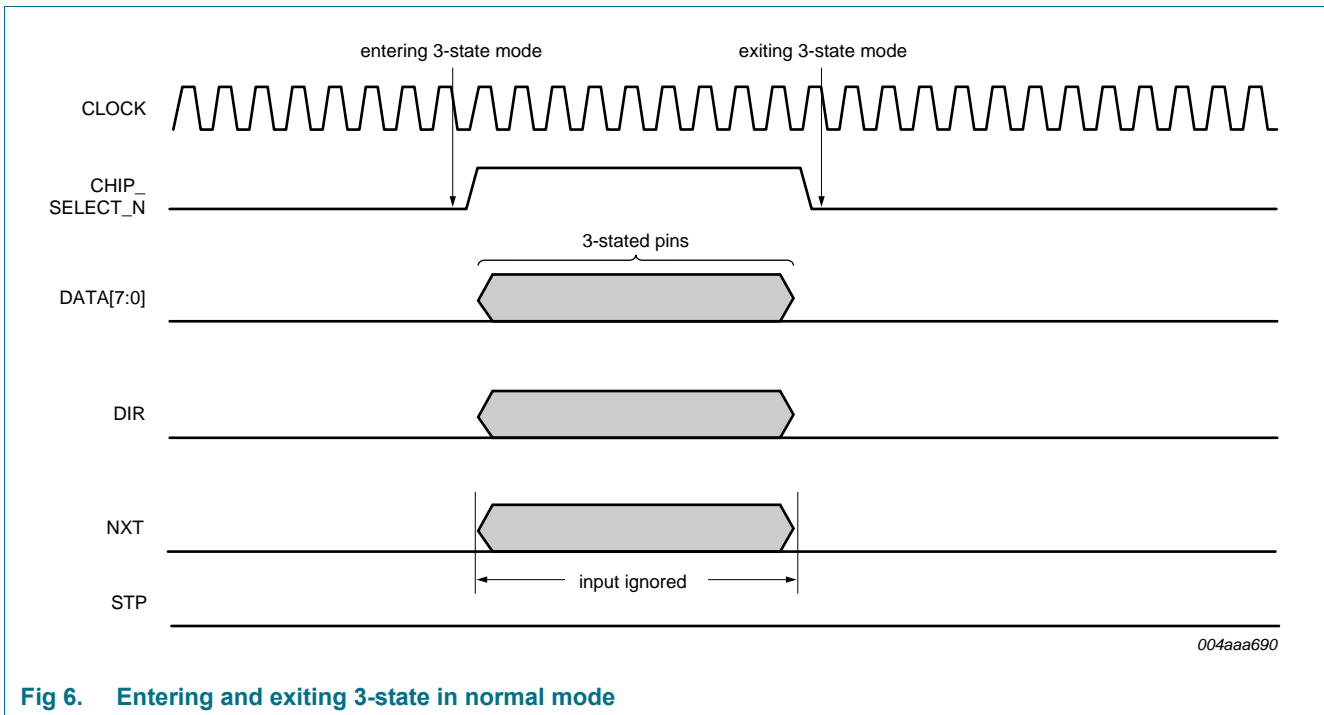
Fig 6.   Entering and exiting 3-state in normal mode
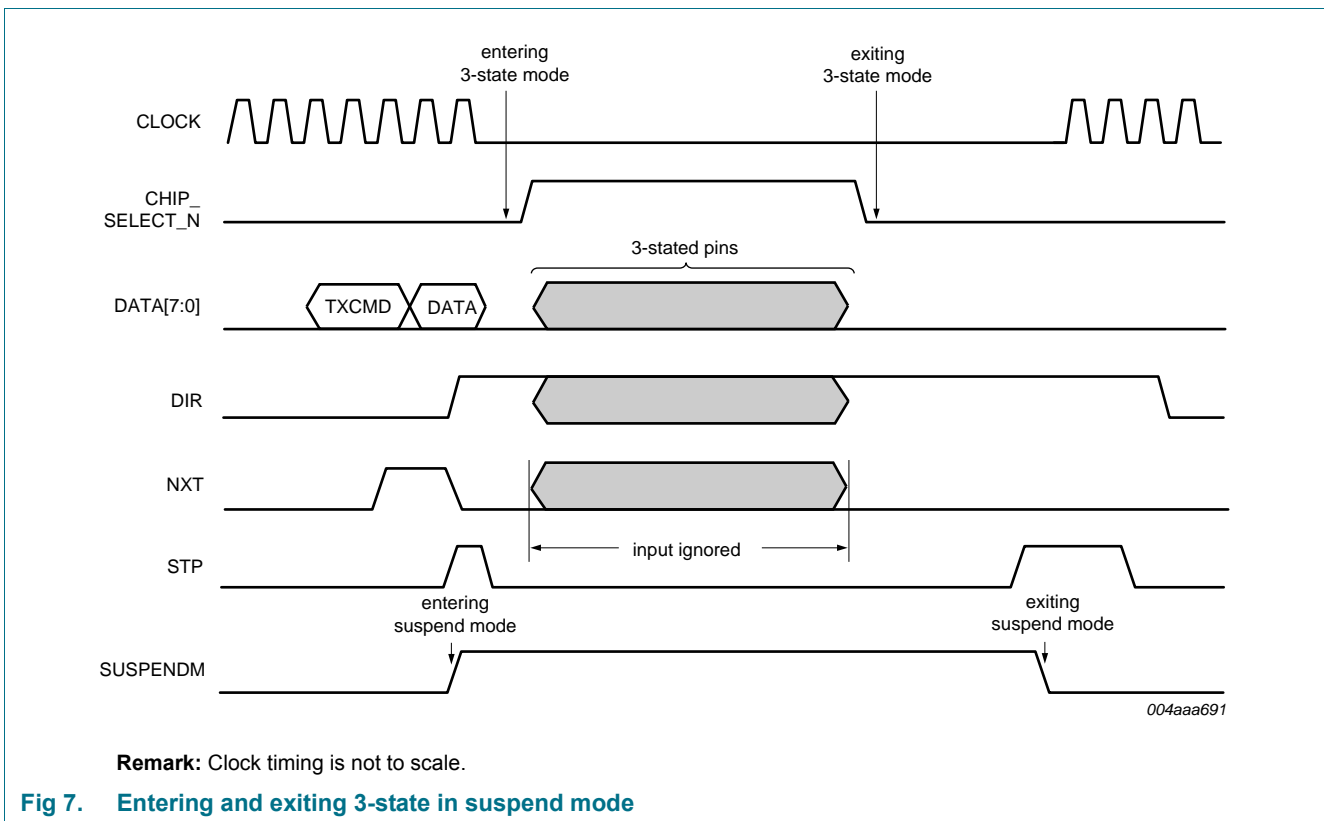
Remark: Clock timing is not to scale.

Fig 7.   Entering and exiting 3-state in suspend mode

10.4 V$_{BUS}$ power and fault detection

10.4.1 Driving 5 V on V$_{BUS}$

The ISP1507x1 also supports external 5 V supplies. The ISP1507x1 can control the external supply using the active-LOW PSW_N open-drain output pin. To enable the external supply by driving PSW_N to LOW, the link must set the DRV_VBUS_EXT bit in the OTG_CTRL register to logic 1.

Table 9 summarizes settings to drive 5 V on V$_{BUS}$.

Table 9.   OTG_CTRL register power control bits

DRV_VBUS_EXT	Power source used
0	external V$_{BUS}$ power sources are disabled
1	external 5 V V$_{BUS}$ supply is enabled

10.4.2 Fault detection

The ISP1507x1 supports external V$_{BUS}$ fault detector circuits that output a digital fault indicator signal. The indicator signal must be connected to the FAULT pin. To enable the ISP1507x1 to monitor the digital fault input, the link must set the USE_EXT_VBUS_IND bit in the OTG_CTRL register (see Section 11.1.4) and the IND_PASSTHRU bit in the INTF_CTRL register (see Section 11.1.3) to logic 1. For details, see Figure 9.

The FAULT input pin is mapped to the A_VBUS_VLD bit in RXCMD. Any changes for the FAULT input will trigger RXCMD carrying the FAULT condition with A_VBUS_VLD.

10.5 TXCMD and RXCMD

Commands between the ISP1507x1 and the link are described in the following subsections.

10.5.1 TXCMD

By default, the link must drive the ULPI bus to its idle state of 00h. To send commands and USB packets, the link drives a nonzero value on DATA[7:0] to the ISP1507x1 by sending a byte called TXCMD. Commands include USB packet transmissions, and register reads and writes. Once the TXCMD is interpreted and accepted by the ISP1507x1, the NXT signal is asserted and the link can follow up with the required number of data bytes. The TXCMD byte format is given in Table 10. Any values other than those in Table 10 are illegal and may result in undefined behavior.

Various TXCMD packet and register sequences are shown in later sections.

Table 10.   TXCMD byte format

Command type name	Command code DATA[7:6]	Command payload DATA[5:0]	Command name	Command description
Idle	00b	00 0000b	NOOP	No operation. 00h is the idle value of the data bus. The link must drive NOOP by default.
Packet transmit	01b	00 0000b	NOPID	Transmit USB data that does not have a PID, such as chirp and resume signaling. The ISP1507x1 starts transmitting only after accepting the next data byte.
		00 XXXXb	PID	Transmit USB packet. DATA[3:0] indicates USB packet identifier PID[3:0].

Table 10. TXCMD byte format *…continued*

| Command type name	Command code DATA[7:6]	Command payload DATA[5:0]	Command name	Command description
Register write	10b	10 1111b	EXTW	Extended register write command (optional). The 8-bit address must be provided after the command is accepted.
		XX XXXXb	REGW	Register write command with 6-bit immediate address.
Register read	11b	10 1111b	EXTR	Extended register read command (optional). The 8-bit address must be provided after the command is accepted.
		XX XXXXb	REGR	Register read command with 6-bit immediate address.

10.5.2 RXCMD

The ISP1507x1 communicates status information to the link by asserting DIR and sending an RXCMD byte on the data bus. The RXCMD data byte format is given in Table 11.

The ISP1507x1 will automatically send an RXCMD whenever there is a change in any of the RXCMD data fields. The link must be able to accept an RXCMD at any time; including single RXCMDs, back-to-back RXCMDs, and RXCMDs at any time during USB receive packets when NXT is LOW. An example is shown in Figure 8. For details and diagrams, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

An RXCMD may not be sent when exiting low-power mode or serial mode, if the interrupt condition is removed before exiting.

Table 11. RXCMD byte format

DATA	Name	Description and value
1 to 0	LINESTATE	**LINESTATE signals**: For a definition of LINESTATE, see Section 10.5.2.1. **DATA0 —** LINESTATE[0] **DATA1 —** LINESTATE[1]
3 to 2	V_{BUS} state	**Encoded V_{BUS} voltage state**: For an explanation of the V_{BUS} state, see Section 10.5.2.2.
5 to 4	RxEvent	**Encoded USB event signals**: For an explanation of RxEvent, see Section 10.5.2.4.
6	ID	Set to the value of the ID pin.
7	ALT_INT	By default, this signal is not used and is not needed in typical designs. Optionally, the link can enable the BVALID_RISE bit, the BVALID_FALL bit, or both in the PWR_CTRL register (see Section 11.1.14). Corresponding changes in BVALID will cause an RXCMD to be sent to the link with the ALT_INT bit asserted.

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Fig 8. Single and back-to-back RXCMDs from the ISP1507x1 to the link
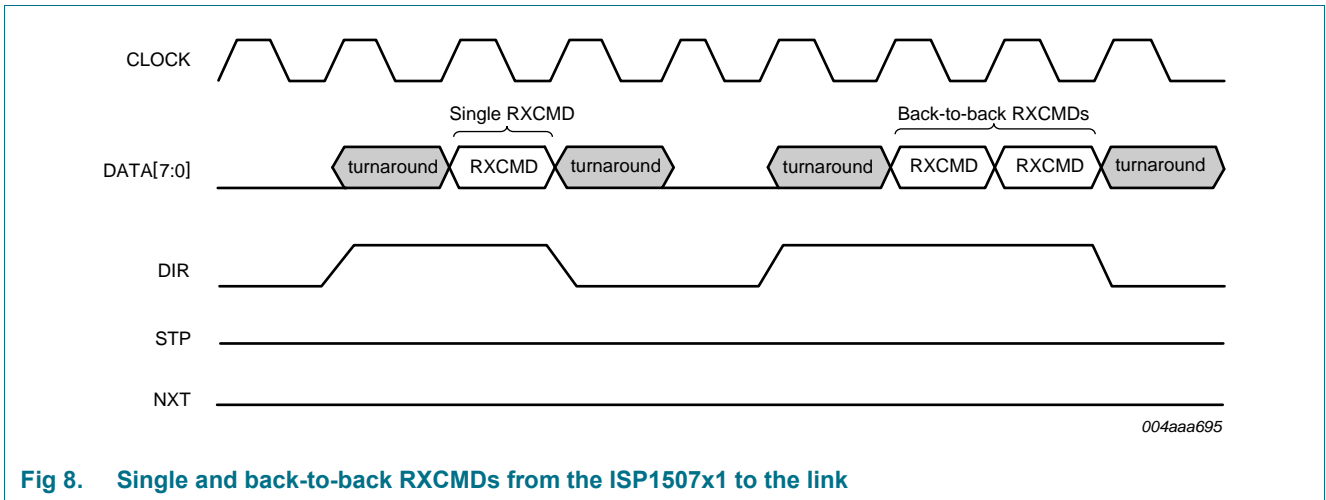
10.5.2.1 Linestate encoding

LINESTATE[1:0] reflects the current state of DP and DM. Whenever the ISP1507x1 detects a change in DP or DM, an RXCMD will be sent to the link with the new LINESTATE[1:0] value. The value given on LINESTATE[1:0] depends on the setting of various registers.

Table 12 shows the LINESTATE[1:0] encoding for upstream facing ports, which applies to peripherals. Table 13 shows the LINESTATE[1:0] encoding for downstream facing ports, which applies to host controllers. Dual-role devices must choose the correct table, depending on whether it is in peripheral or host mode.

Table 12. LINESTATE[1:0] encoding for upstream facing ports: peripheral
DP_PULLDOWN = 0.[1]

Mode		Full-speed	High-speed	Chirp
XCVRSELECT[1:0]		01, 11	00	00
TERMSELECT		1	0	1
LINESTATE[1:0]	00	SE0	squelch	squelch
	01	FS-J	!squelch	!squelch and HS_Differential_Receiver_Output
	10	FS-K	invalid	!squelch and !HS_Differential_Receiver_Output
	11	SE1	invalid	invalid

[1] !squelch indicates inactive squelch. !HS_Differential_Receiver_Output indicates inactive HS_Differential_Receiver_Output.

Table 13. LINESTATE[1:0] encoding for downstream facing ports: host DP_PULLDOWN and DM_PULLDOWN = 1.[1]

Mode		Low-speed	Full-speed	High-speed	Chirp
XCVRSELECT[1:0]		10	01, 11	00	00
TERMSELECT		1	1	0	0
OPMODE[1:0]		X	X	00, 01, or 11	10
LINESTATE[1:0]	00	SE0	SE0	squelch	squelch
	01	LS-K	FS-J	!squelch	!squelch and HS_Differential_Receiver_Output
	10	LS-J	FS-K	invalid	!squelch and !HS_Differential_Receiver_Output
	11	SE1	SE1	invalid	invalid

[1] !squelch indicates inactive squelch. !HS_Differential_Receiver_Output indicates inactive HS_Differential_Receiver_Output.

10.5.2.2 V_{BUS} state encoding

USB devices must monitor the V_{BUS} voltage for purposes such as overcurrent detection, starting a session, and SRP. The V_{BUS} state field in the RXCMD is an encoding of the voltage level on V_{BUS}.

The SESS_END and SESS_VLD indicators in the V_{BUS} state are directly taken from internal comparators built-in to the ISP1507x1, and encoded as shown in Table 11 and Table 14.

Table 14. Encoded V_{BUS} voltage state

Value	V_{BUS} voltage	SESS_END	SESS_VLD	A_VBUS_VLD
00	$V_{BUS} < V_{B\_SESS\_END}$	1	0	0
01	$V_{B\_SESS\_END} \leq V_{BUS} < V_{B\_SESS\_VLD}$	0	0	0
10	$V_{B\_SESS\_VLD} \leq V_{BUS} < V_{A\_VBUS\_VLD}$	X	1	0
11	$V_{BUS} \geq V_{A\_VBUS\_VLD}$	X	X	1

The A_VBUS_VLD indicator in the V_{BUS} state provides several options and must be configured based on current draw requirements. A_VBUS_VLD can input from one or more V_{BUS} voltage indicators, as shown in Figure 9.

A description on how to use and select the V_{BUS} state encoding is given in Section 10.5.2.3.

A_VBUS_VLD comparator

internal A_VBUS_VLD

V_{BUS}

(0, X)

(1, 0)

RXCMD
A_VBUS_VLD

FAULT indicator

complement output

FAULT

(1, 1)

IND_COMPL

USE_EXT_VBUS_IND,
IND_PASSTHRU

004aaa698
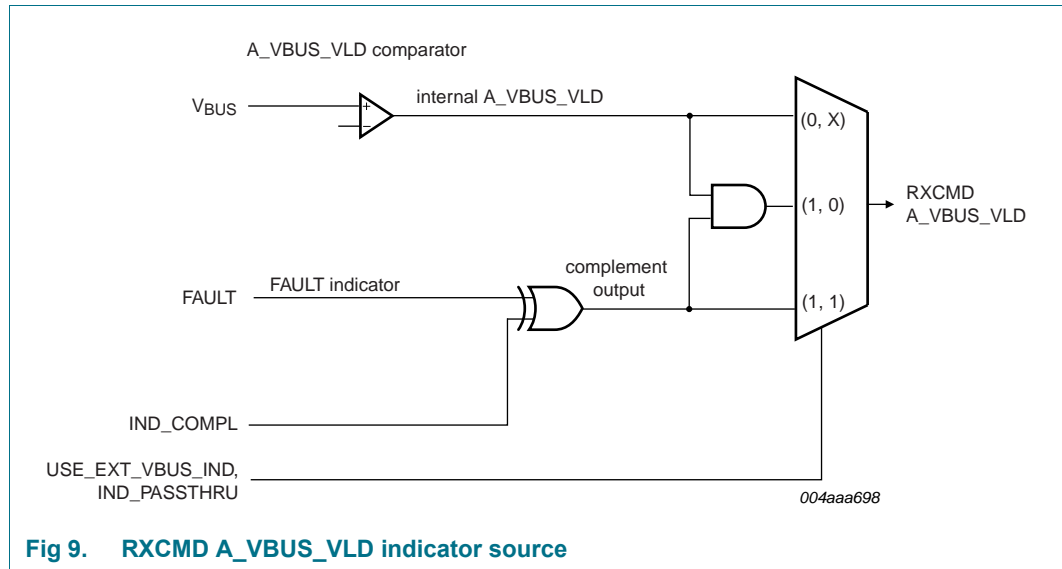
Fig 9.   RXCMD A_VBUS_VLD indicator source

10.5.2.3 Using and selecting the V_{BUS} state encoding

The V_{BUS} state encoding is shown in Table 11. The ISP1507x1 will send an RXCMD to the link whenever there is a change in the V_{BUS} state. To receive V_{BUS} state updates, the link must first enable the corresponding interrupts in the USB_INTR_EN_R_E and USB_INTR_EN_F_E registers.

The link can use the V_{BUS} state to monitor V_{BUS} and take appropriate action. Table 15 shows the recommended usage for typical applications.

Table 15. V_{BUS} indicators in RXCMD required for typical applications

Application	A_VBUS_VLD	SESS_VLD	SESS_END
Standard host	yes	no	no
Standard peripheral	no	yes	no
OTG A-device	yes	yes	no
OTG B-device	no	yes	yes

Standard USB host controllers: For standard hosts, the system must be able to provide 500 mA on V_{BUS} in the range of 4.75 V to 5.25 V. An external circuit must be used to detect overcurrent conditions. If the external overcurrent detector provides a digital fault signal, then the fault signal must be connected to the ISP1507x1 FAULT input pin, and the link must do the following:

1. Set the IND_COMPL bit in the INTF_CTRL register (see Section 11.1.3) to logic 0 or logic 1, depending on the polarity of the external fault signal.
2. Set the USE_EXT_VBUS_IND bit in the OTG_CTRL register (see Section 11.1.4) to logic 1.
3. If it is not necessary to qualify the fault indicator with the internal A_VBUS_VLD comparator, set the IND_PASSTHRU bit in the INTF_CTRL register to logic 1.

Standard USB peripheral controllers: Standard peripherals must be able to detect when V_{BUS} is at a sufficient level for operation. SESS_VLD must be enabled to detect the start and end of USB peripheral operations. Detection of A_VBUS_VLD and SESS_END thresholds is not needed for standard peripherals.

OTG devices: When an OTG device is configured as an OTG A-device, it must be able to provide a minimum of 8 mA on V_{BUS}. If the OTG A-device provides less than 100 mA, then there is no need for an overcurrent detection circuit because the internal A_VBUS_VLD comparator is sufficient. If the OTG A-device provides more than 100 mA on V_{BUS}, an overcurrent detector must be used and Section "Standard USB host controllers" applies. The OTG A-device also uses SESS_VLD to detect when an OTG B-device is initiating V_{BUS} pulsing SRP.

When an OTG device is configured as an OTG B-device, SESS_VLD must be used to detect when V_{BUS} is at a sufficient level for operation. SESS_END must be used to detect when V_{BUS} has dropped to a LOW level, allowing the B-device to safely initiate V_{BUS} pulsing SRP.

10.5.2.4 RxEvent encoding

The RxEvent field (see Table 16) of the RXCMD informs the link of information related packets received on the USB bus. RxActive and RxError are defined in *USB 2.0 Transceiver Macrocell Interface (UTMI) Specification Ver. 1.05*. HostDisconnect is defined in *UTMI+ Specification Rev. 1.0*. A short definition is also given in the following subsections.

Table 16. Encoded USB event signals

Value	RxActive	RxError	HostDisconnect
00	0	0	0
01	1	0	0
11	1	1	0
10	X	X	1

RxActive: When the ISP1507x1 has detected a SYNC pattern on the USB bus, it signals an RxActive event to the link. An RxActive event can be communicated using two methods. The first method is for the ISP1507x1 to simultaneously assert DIR and NXT. The second method is for the ISP1507x1 to send an RXCMD to the link with the RxActive field in RxEvent bits set to logic 1. The link must be able to detect both methods. RxActive frames the receive packet from the first byte to the last byte.

The link must assume that RxActive is set to logic 0 when indicated in an RXCMD or when DIR is deasserted, whichever occurs first.

The link uses RxActive to time high-speed packets and ensure that bus turnaround times are met. For more information on the USB packet timing, see Section 10.8.1.

RxError: When the ISP1507x1 has detected an error while receiving a USB packet, it deasserts NXT and sends an RXCMD with the RxError field set to logic 1. The received packet is no longer valid and must be dropped by the link.

HostDisconnect: HostDisconnect is encoded into the RxEvent field of the RXCMD. HostDisconnect is valid only when the ISP1507x1 is configured as a host (both DP_PULLDOWN and DM_PULLDOWN are set to logic 1), and indicates to the host controller when a peripheral is connected or disconnected. The host controller must enable HostDisconnect by setting the HOST_DISCON_R and HOST_DISCON_F bits in the USB_INTR_EN_R_E and USB_INTR_EN_F_E registers, respectively. Changes in HostDisconnect will cause the PHY to send an RXCMD to the link with the updated value.

10.6 Register read and write operations

Figure 10 shows register read and write sequences. The ISP1507x1 supports immediate addressing and extended addressing register operations. Extended register addressing is optional for links. Note that register operations will be aborted if the ISP1507x1 unexpectedly asserts DIR during the operation. When a register operation is aborted, the link must retry until successful. For more information on register operations, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

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AD indicates the address byte. D indicates the data byte.
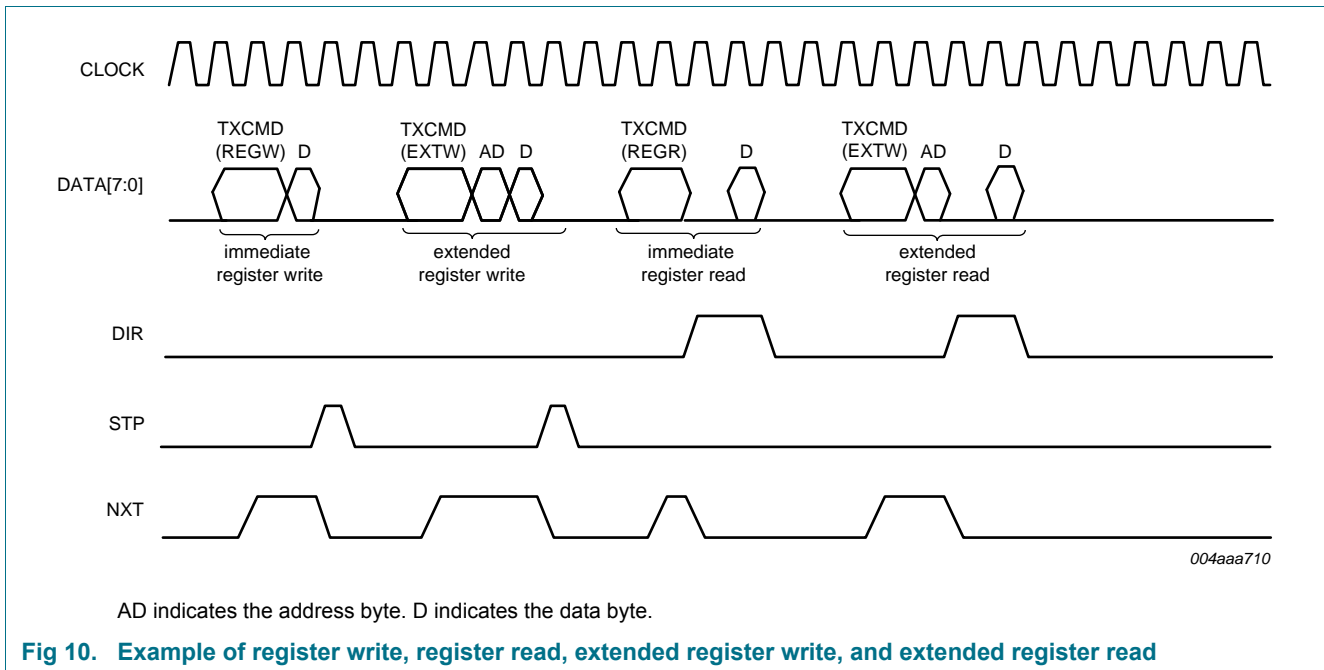
Fig 10. Example of register write, register read, extended register write, and extended register read

10.7 USB reset and high-speed detection handshake (chirp)

Figure 11 shows the sequence of events for USB reset and high-speed detection handshake (chirp). The sequence is shown for hosts and peripherals. Figure 11 does not show all RXCMD updates and timing is not to scale. The sequence is as follows:

1. USB reset: The host detects a peripheral attachment as low-speed if DM is HIGH and as full-speed if DP is HIGH. If a host detects a low-speed peripheral, it does not follow the remainder of this protocol. If a host detects a full-speed peripheral, it resets the peripheral by writing to the Function Control register (see Section 11.1.2). XCVRSELECT[1:0] = 00b (high-speed) and TERMSELECT = 0b are then set which drives SE0 on the bus (DP and DM are connected to ground through 45 Ω). The host also sets OPMODE[1:0] = 10b for correct chirp transmit and receive. The start of SE0 is labeled T_0.

   Remark: To receive chirp signaling, the host must also consider the high-speed differential receiver output. The host controller must interpret LINESTATE[1:0] as shown in Table 13.

2. High-speed detection handshake (chirp)

   a. Peripheral chirp: After detecting SE0 for no less than 2.5 μs, if the peripheral is capable of high-speed, it sets XCVRSELECT[1:0] = 00b (high-speed) and OPMODE[1:0] = 10b (chirp). The peripheral immediately follows this with a TXCMD (NOPID), transmitting a Chirp K for no less than 1 ms and ending no more

than 7 ms after reset time T_0. If the peripheral is in low-power mode, it must wake up its clock within 5.6 ms, leaving 200 μs for the link to start transmitting the Chirp K, and 1.2 ms for the Chirp K to complete (worst case with 10% slow clock).

b. Host chirp: If the host does not detect the peripheral chirp, it must continue asserting SE0 until the end of reset. If the host detects the peripheral Chirp K for no less than 2.5 μs, then no more than 100 μs after the bus leaves the Chirp K state, the host sends a TXCMD (NOPID) with an alternating sequence of Chirp Ks and Js. Each Chirp K or Chirp J must last no less than 40 μs and no longer than 60 μs.

c. High-speed idle: The peripheral must detect a minimum of Chirp K-J-K-J-K-J. Each Chirp K and Chirp J must be detected for at least 2.5 μs. The peripheral sets TERMSELECT = 0b and OPMODE[1:0] = 00b after seeing the minimum Chirp sequence. The peripheral is now in high-speed mode and sees !squelch (01b on LINESTATE). When the peripheral sees squelch (10b on LINESTATE), it knows that the host has completed chirp and waits for Hi-Speed USB traffic to begin. After transmitting the chirp sequence, the host changes OPMODE[1:0] to 00b and begins sending USB packets.

For more information, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

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Timing is not to scale.
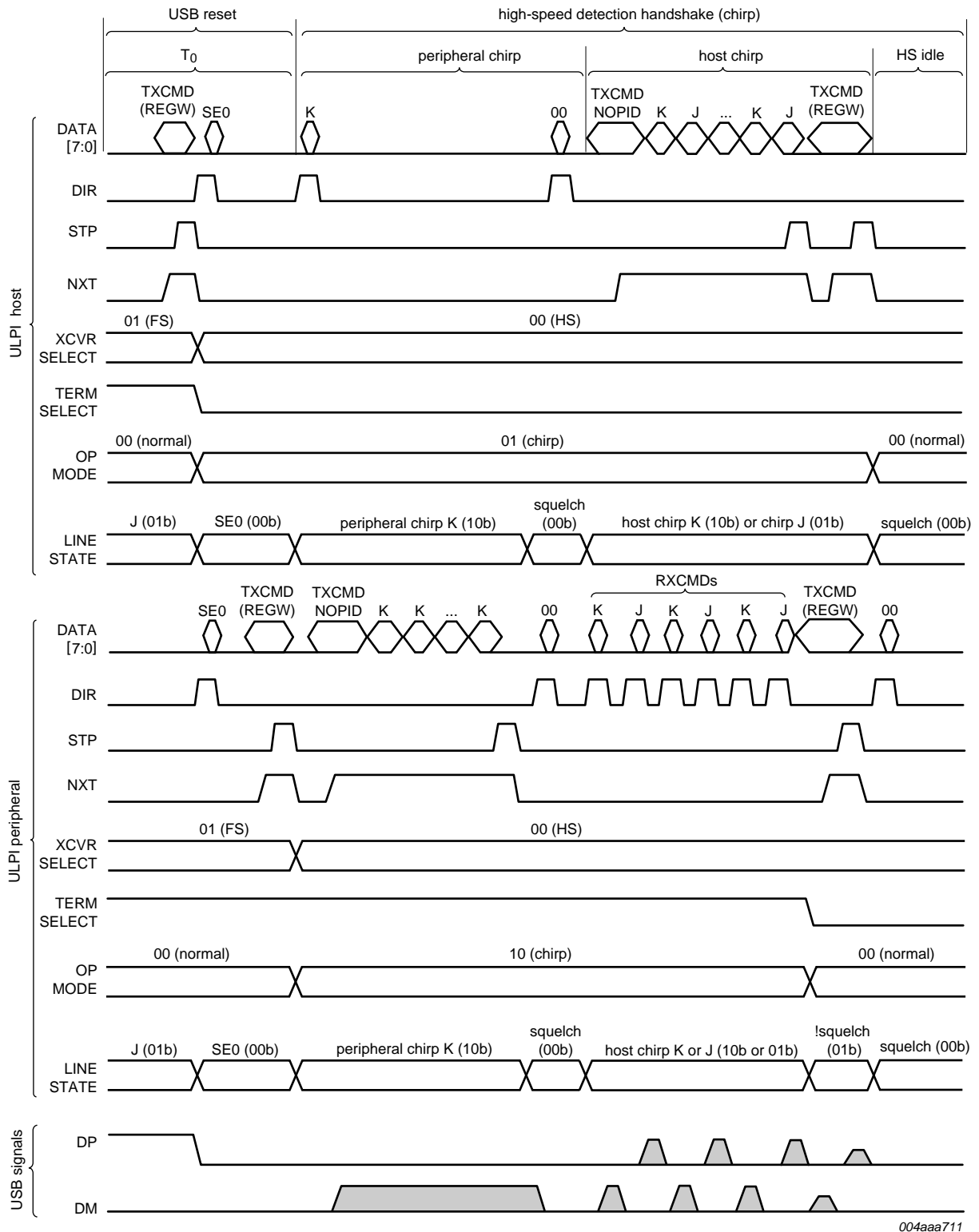
Fig 11.   USB reset and high-speed detection handshake (chirp) sequence

10.8 USB packet transmit and receive

An example of a packet transmit and receive is shown in Figure 12. For details on USB packets, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.
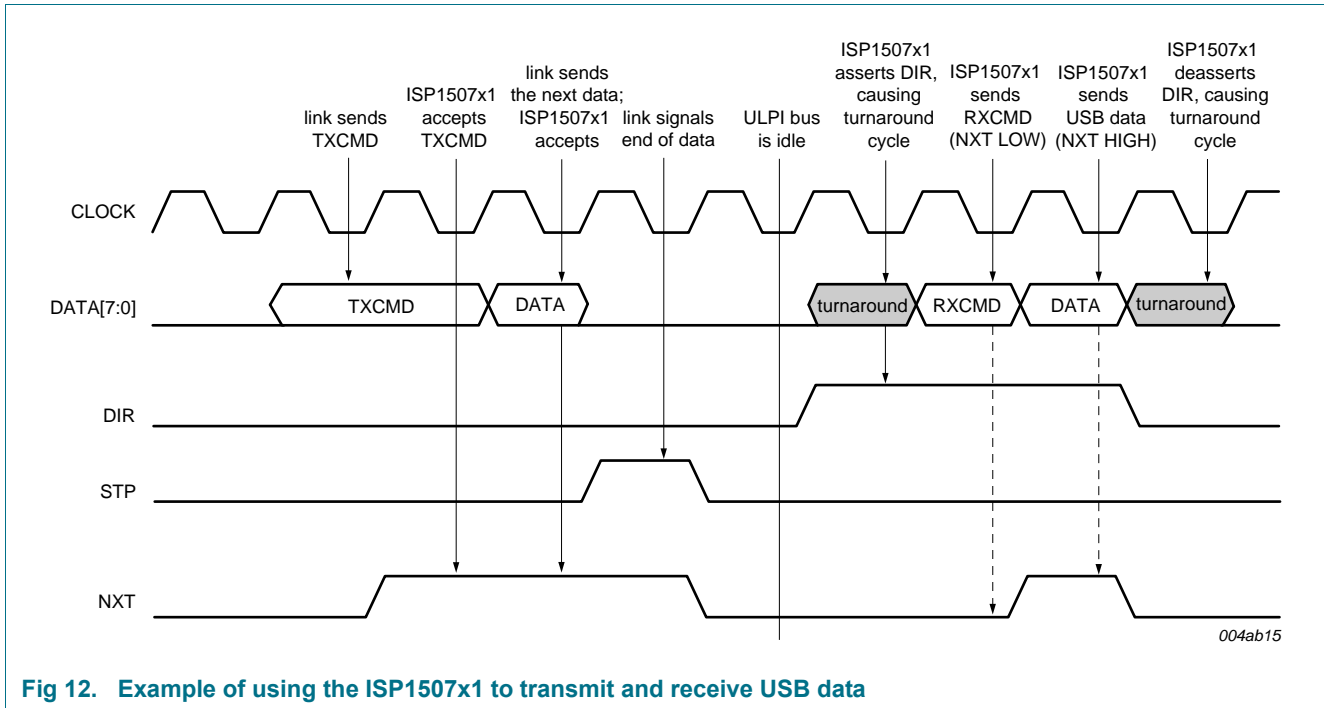
Fig 12.   Example of using the ISP1507x1 to transmit and receive USB data

10.8.1 USB packet timing

10.8.1.1 ISP1507x1 pipeline delays

The ISP1507x1 delays are shown in Table 17. For a detailed description, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1, Section 3.8.2.6.2*.

Table 17.   PHY pipeline delays

Parameter name[1]	High-speed PHY delay	Full-speed PHY delay	Low-speed PHY delay
RXCMD delay (J and K)	4	4	4
RXCMD delay (SE0)	4	4 to 6	16 to 18
TX start delay	1 to 2	6 to 10	74 to 75
TX end delay (packets)	3 to 4	not applicable	not applicable
TX end delay (SOF)	6 to 9	not applicable	not applicable
RX start delay	5 to 6	not applicable	not applicable
RX end delay	5 to 6	17 to 18	122 to 123

[1]   According to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1, Section 3.8.2.6*, the TX and RX start or end delays must be used for high-speed inter-packet timing. If the link uses RXCMDs for high-speed inter-packet timing, the result cannot be guaranteed.

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10.8.1.2 Allowed link decision time

The amount of clock cycles allocated to the link to respond to a received packet and correctly receive back-to-back packets is given in Table 18. Link designs must follow values given in Table 18 for correct USB system operation. Examples of high-speed packet sequences and timing are shown in Figure 13 and Figure 14. For details, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1, Section 3.8.2.6.3*.

Table 18.   Link decision times

Packet sequence	High-speed link delay	Full-speed link delay	Low-speed link delay	Definition
Transmit-Transmit (host only)	15 to 24	7 to 18	77 to 247	Number of clock cycles a host link must wait before driving the TXCMD for the second packet.
				In high-speed, the link starts counting from the assertion of STP for the first packet.
				In full-speed, the link starts counting from the RXCMD, indicating LINESTATE has changed from SE0 to J for the first packet. The timing given ensures inter-packet delays of 2 bit times to 6.5 bit times.
Receive-Transmit (host or peripheral)	1 to 14	7 to 18	77 to 247	Number of clock cycles the link must wait before driving the TXCMD for the transmit packet.
				In high-speed, the link starts counting from the end of the receive packet; deassertion of DIR or an RXCMD, indicating RxActive is LOW.
				In full-speed or low-speed, the link starts counting from the RXCMD, indicating LINESTATE has changed from SE0 to J for the receive packet. The timing given ensures inter-packet delays of 2 bit times to 6.5 bit times.
Receive-Receive (peripheral only)	1	1	1	Minimum number of clock cycles between consecutive receive packets. The link must be able to receive both packets.
Transmit-Receive (host or peripheral)	92	80	718	Host or peripheral transmits a packet and will time-out after this number of clock cycles if a response is not received. Any subsequent transmission can occur after this time.
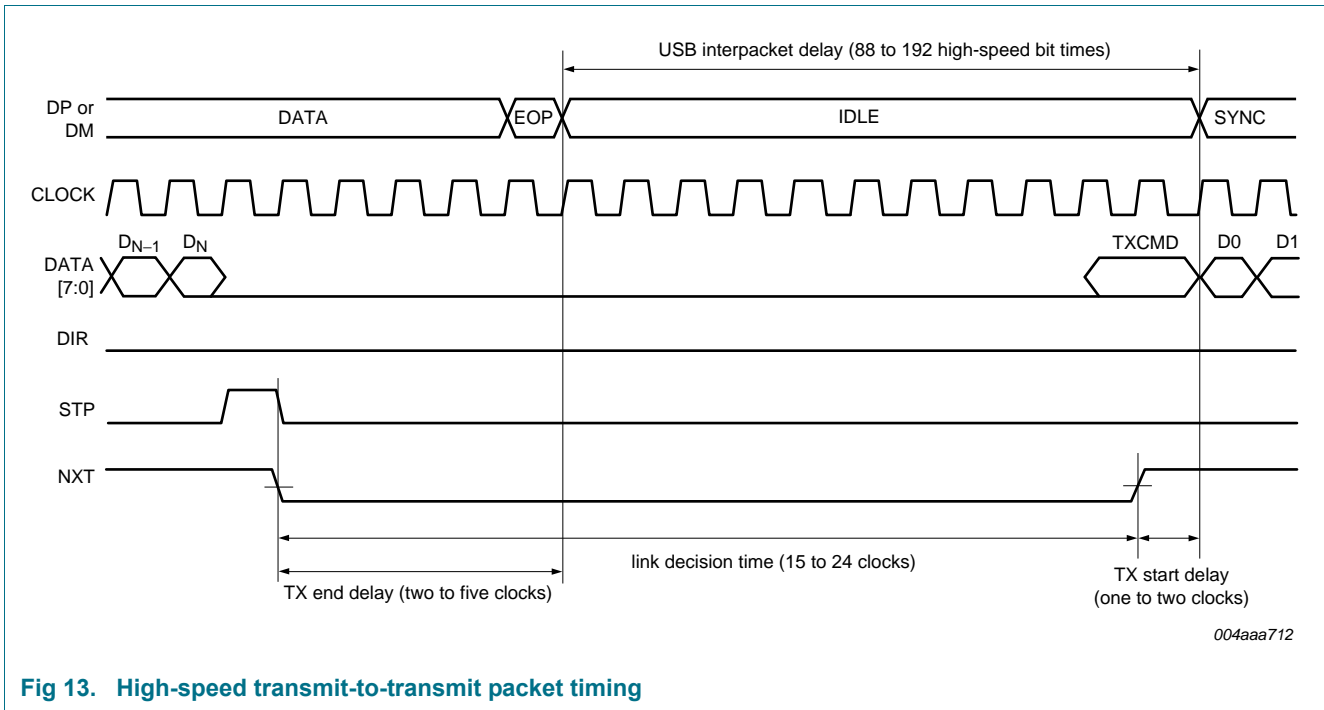
Fig 13. High-speed transmit-to-transmit packet timing
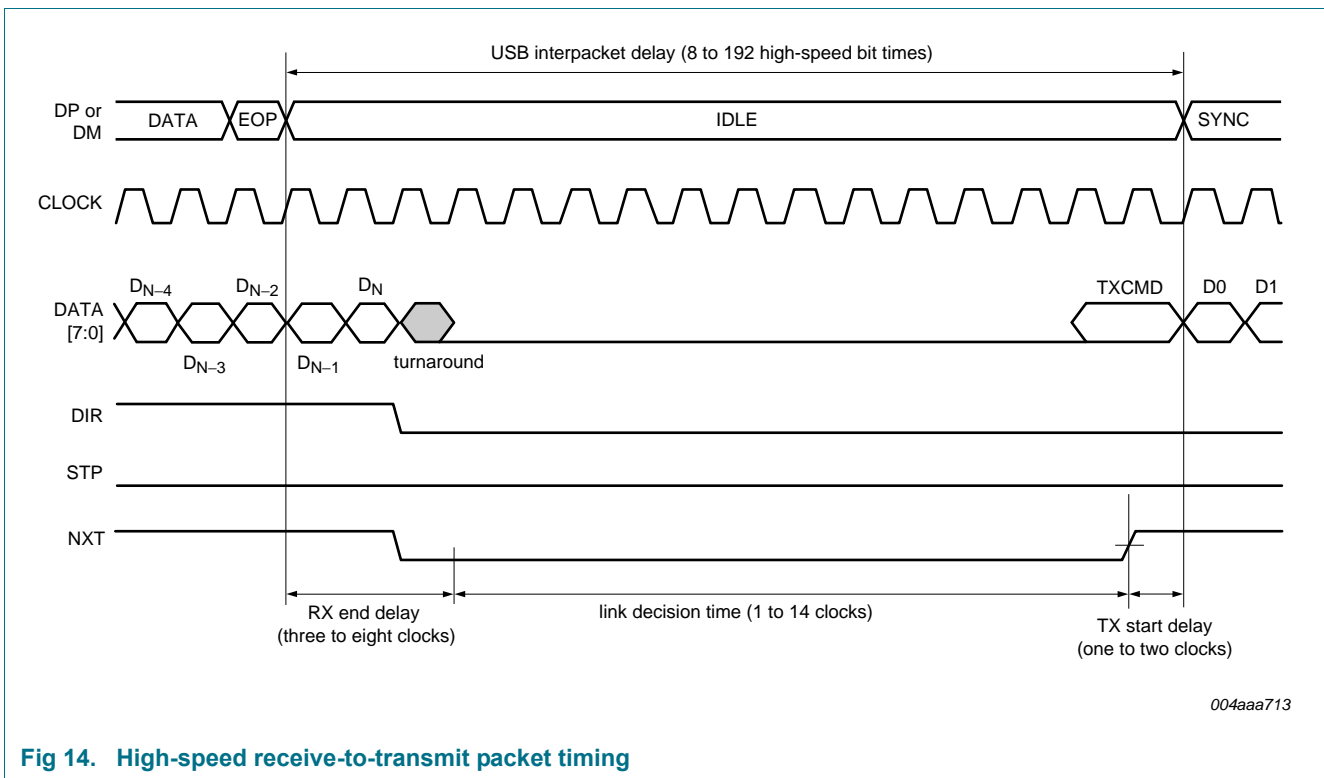
Fig 14. High-speed receive-to-transmit packet timing

10.9 Preamble

Preamble packets are headers to low-speed packets that must travel over a full-speed bus, between a host and a hub. To enter preamble mode, the link sets XCVRSELECT[1:0] = 11b in the FUNC_CTRL register (see Section 11.1.2). When in

preamble mode, the ISP1507x1 operates just as in full-speed mode, and sends all data with the full-speed rise time and fall time. Whenever the link transmits a USB packet in preamble mode, the ISP1507x1 will automatically send a preamble header at full-speed bit rate before sending the link packet at low-speed bit rate. The ISP1507x1 will ensure a minimum gap of four full-speed bit times between the last bit of the full-speed PRE PID and the first bit of the low-speed packet SYNC. The ISP1507x1 will drive a J for at least one full-speed bit time after sending the PRE PID, after which the pull-up resistor can hold the J state on the bus. An example transmit packet is shown in Figure 15.

In preamble mode, the ISP1507x1 can also receive low-speed packets from the full-speed bus.

DP and DM timing is not to scale.

Fig 15. Preamble sequence
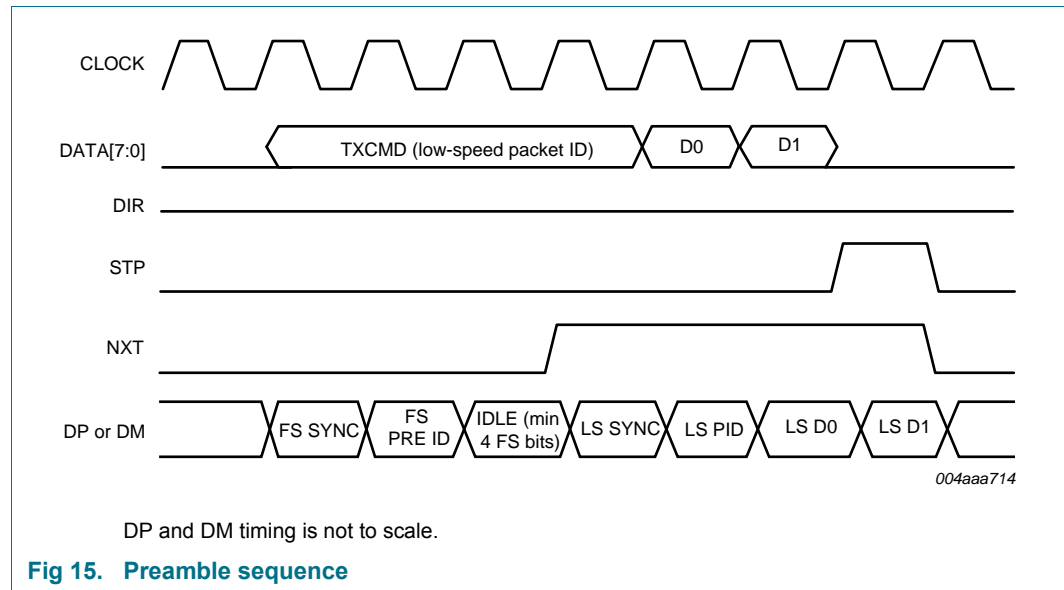
10.10 USB suspend and resume

10.10.1 Full-speed or low-speed host-initiated suspend and resume

Figure 16 illustrates how a host or a hub places a full-speed or low-speed peripheral into suspend and sometime later initiates resume signaling to wake up the downstream peripheral. Note that Figure 16 timing is not to scale, and does not show all RXCMD LINESTATE updates.

The sequence of events for a host and a peripheral, both with ISP1507x1, is as follows:

1. Idle: Initially, the host and the peripheral are idle. The host has its 15 kΩ pull-down resistors enabled (DP_PULLDOWN and DM_PULLDOWN are set to 1b) and 45 Ω terminations disabled (TERMSELECT is set to 1b). The peripheral has the 1.5 kΩ pull-up resistor connected to DP for full-speed or DM for low-speed (TERMSELECT is set to 1b).

2. Suspend: When the peripheral sees no bus activity for 3 ms, it enters the suspend state. The peripheral link places the PHY into low-power mode by clearing the SUSPENDM bit in the FUNC_CTRL register (see Section 11.1.2), causing the PHY to draw only suspend current. The host may or may not be powered down.

3. Resume K: When the host wants to wake up the peripheral, it sets OPMODE[1:0] to 10b and transmits a K for at least 20 ms. The peripheral link sees the resume K on LINESTATE, and asserts STP to wake up the PHY.

4. EOP: When STP is asserted, the ISP1507x1 on the host side automatically appends an EOP of two bits of SE0 at low-speed bit rate, followed by one bit of J. The ISP1507x1 on the host side knows to add the EOP because DP_PULLDOWN and DM_PULLDOWN are set to 1b for a host. After the EOP is completed, the host link sets OPMODE[1:0] to 00b for normal operation. The peripheral link sees the EOP and also resumes normal operation.

Fig 16. Full-speed suspend and resume
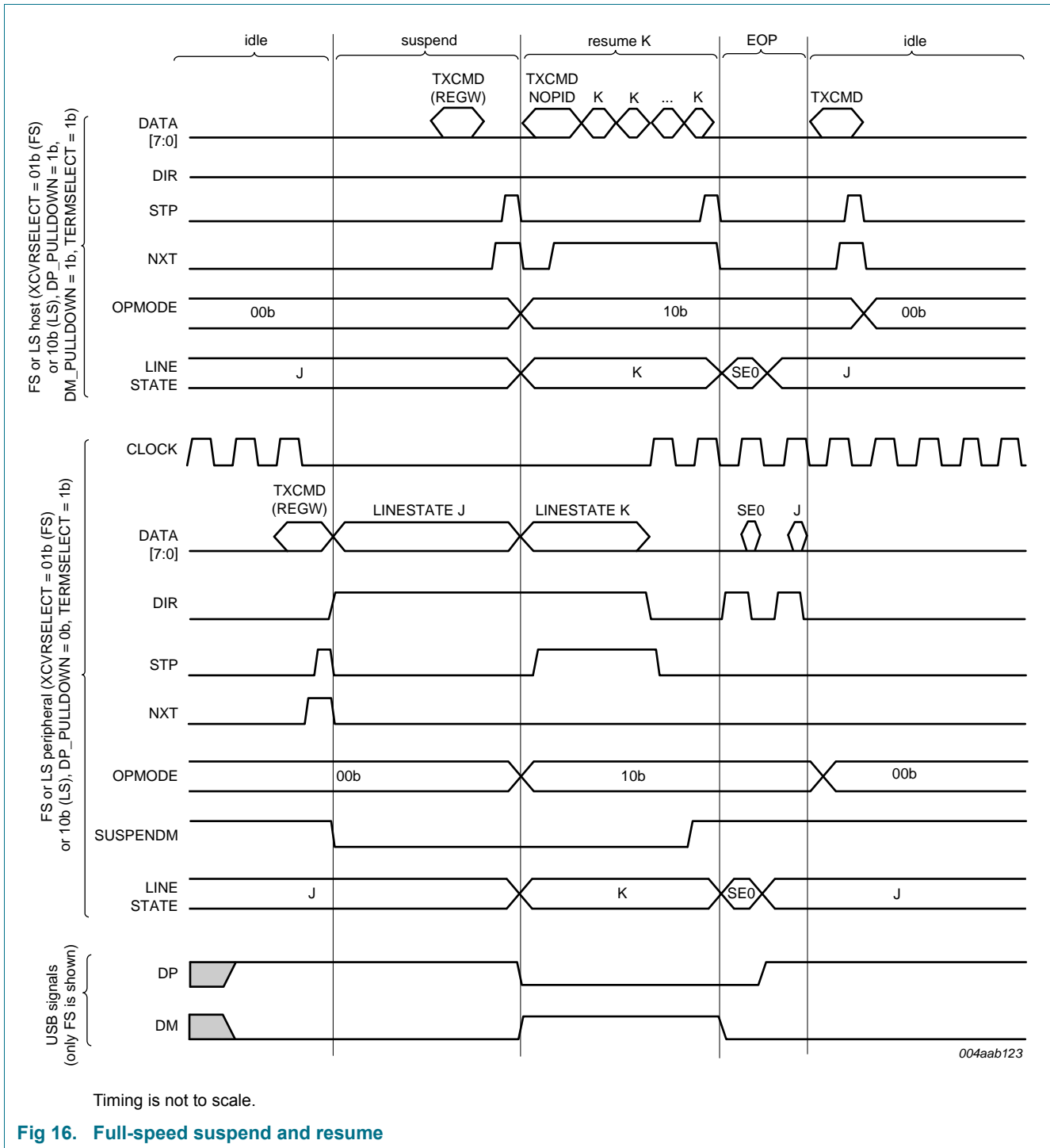
10.10.2 High-speed suspend and resume

Figure 17 illustrates how a host or a hub places a high-speed enabled peripheral into suspend and then initiates resume signaling. The high-speed peripheral will wake up and return to high-speed operations. Note that Figure 17 timing is not to scale, and does not show all RXCMD LINESTATE updates.

The sequence of events related to a host and a peripheral, both with ISP1507x1, is as follows:

1. High-speed idle: Initially, the host and the peripheral are idle. The host has its 15 kΩ pull-down resistors enabled (DP_PULLDOWN and DM_PULLDOWN are set to 1b) and 45 Ω terminations enabled (TERMSELECT is set to 0b). The peripheral has its 45 Ω terminations enabled (TERMSELECT is set to 0b).

2. Full-speed suspend: When the peripheral sees no bus activity for 3 ms, it enters the suspend state. The peripheral link places the ISP1507x1 into full-speed mode (XCVRSELECT is set to 01b), removes 45 Ω terminations, and enables the 1.5 kΩ pull-up resistor on DP (TERMSELECT is set to 1b). The peripheral link then places the ISP1507x1 into low-power mode by clearing SUSPENDM, causing the ISP1507x1 to draw only suspend current. The host also changes the ISP1507x1 to full-speed (XCVRSELECT is set to 01b), removes 45 Ω terminations (TERMSELECT is set to 1b), and then may or may not be powered down.

3. Resume K: When the host wants to wake up the peripheral, it sets OPMODE to 10b and transmits a full-speed K for at least 20 ms. The peripheral link sees the resume K (10b) on LINESTATE, and asserts STP to wake up the ISP1507x1.

4. High-speed traffic: The host link sets high-speed (XCVRSELECT is set to 00b) and enables its 45 Ω terminations (TERMSELECT is set to 0b). The peripheral link sees SE0 on LINESTATE and also sets high-speed (XCVRSELECT is set to 00b), and enables its 45 Ω terminations (TERMSELECT is set to 0b). The host link sets OPMODE to 00b for normal high-speed operation.

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Timing is not to scale.
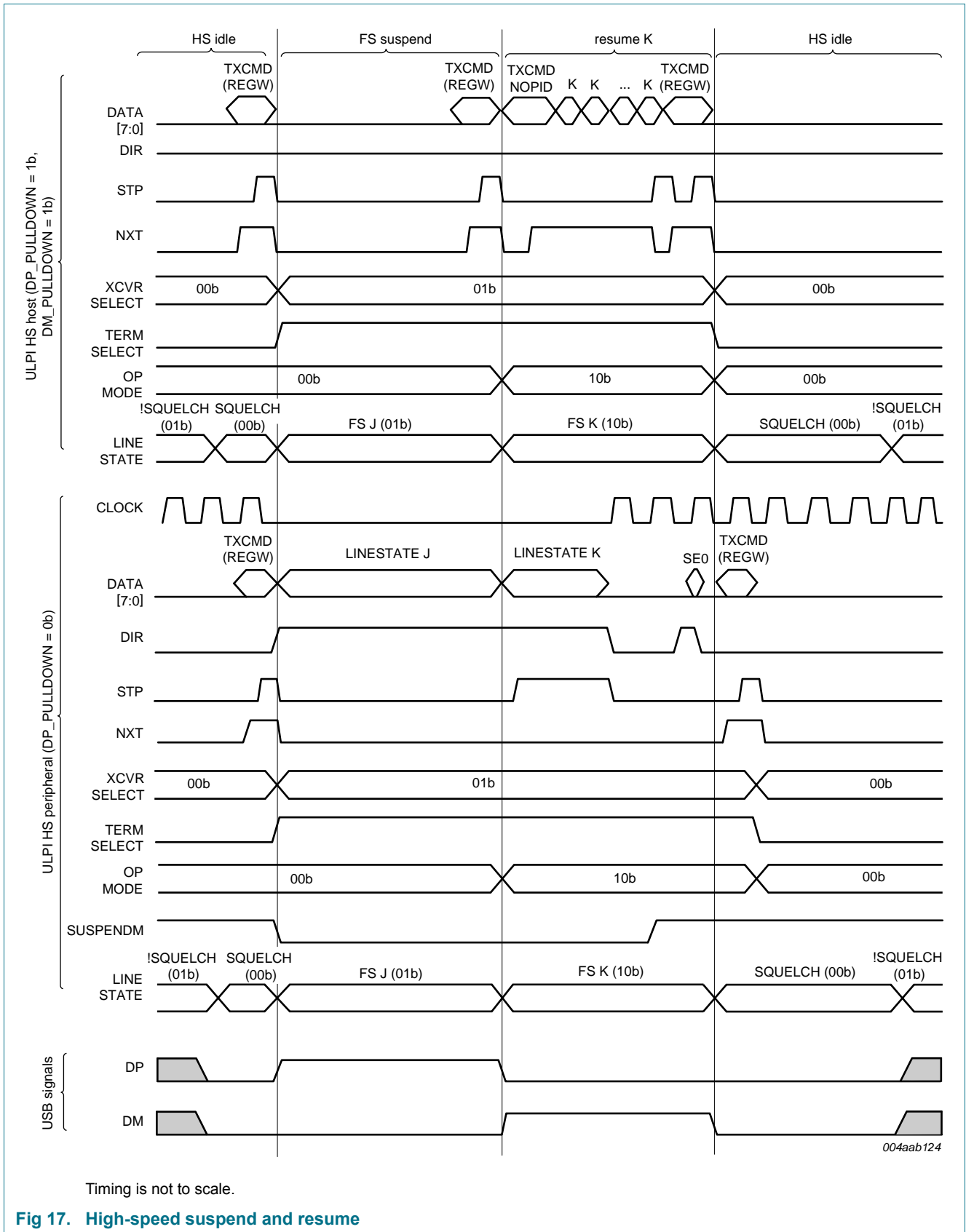
Fig 17. High-speed suspend and resume

10.10.3 Remote wake-up

The ISP1507x1 supports peripherals that initiate remote wake-up resume. When placed into USB suspend, the peripheral link remembers at what speed it was originally operating. Depending on the original speed, the link follows one of the protocols detailed here. In Figure 18, timing is not to scale, and not all RXCMD LINESTATE updates are shown.

The sequence of events related to a host and a peripheral, both with ISP1507x1, is as follows:

1. Both the host and the peripheral are assumed to be in low-power mode.

2. The peripheral begins remote wake-up by re-enabling its clock and setting its SUSPENDM bit to 1b.

3. The peripheral begins driving K on the bus to signal resume. Note that the peripheral link must assume that LINESTATE is K (01b) while transmitting because it will not receive any RXCMDs.

4. The host recognizes the resume, re-enables its clock and sets its SUSPENDM bit.

5. The host takes over resume driving within 1 ms of detecting the remote wake-up.

6. The peripheral stops driving resume.

7. The peripheral sees the host continuing to drive resume.

8. The host stops driving resume and the ISP1507x1 automatically adds the EOP to the end of resume. The peripheral recognizes the EOP as the end of resume.

9. Both the host and the peripheral revert to normal operation by writing 00b to OPMODE. If the host or the peripheral was previously in high-speed mode, it must revert to high-speed before the SE0 of the EOP is completed. This can be achieved by writing XCVRSELECT[1:0] = 00b and TERMSELECT = 0b after LINESTATE indicates SE0.

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Timing is not to scale.

Fig 18. Remote wake-up from low-power mode
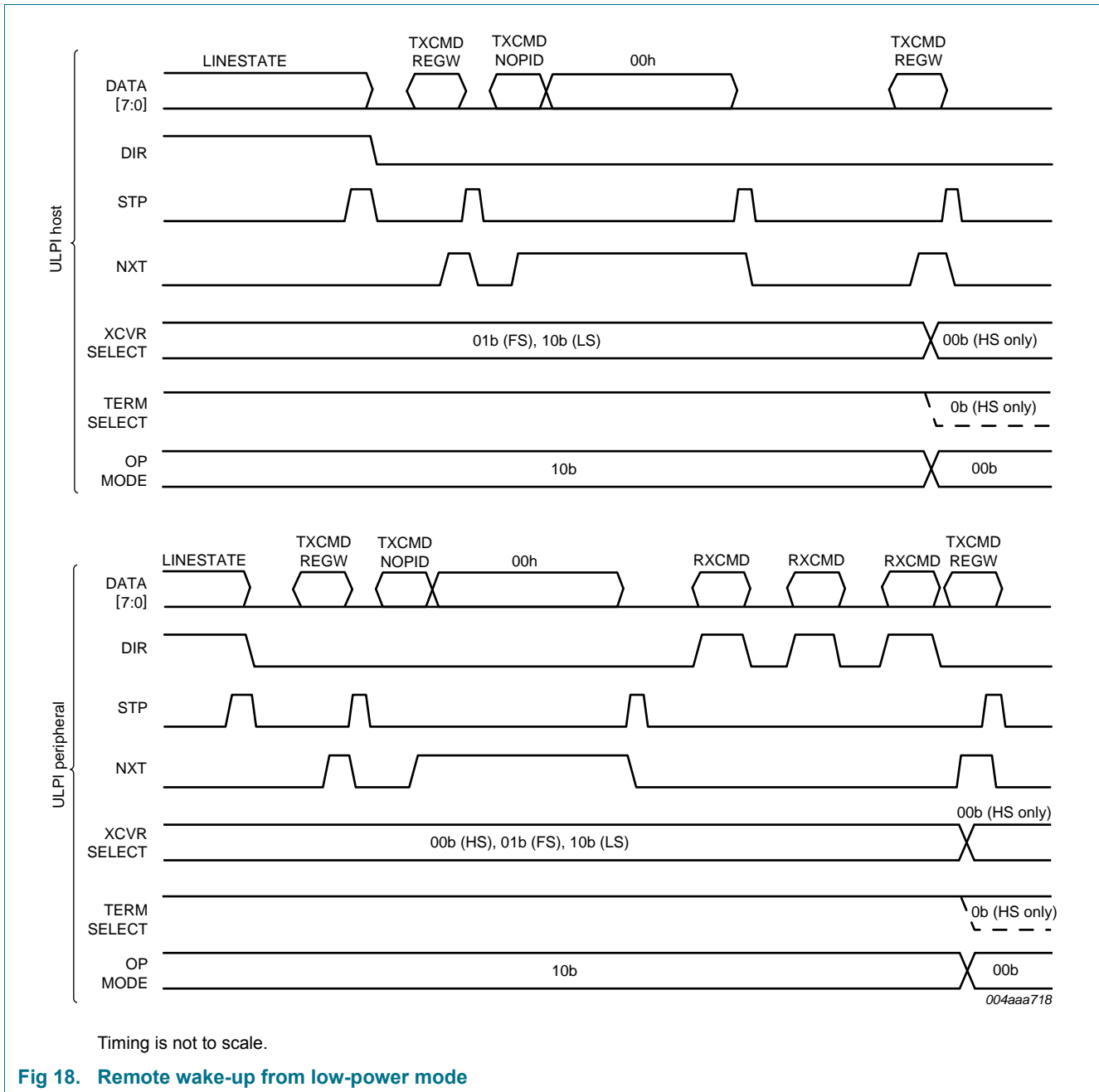
10.11 No automatic SYNC and EOP generation (optional)

This setting allows the link to turn off the automatic SYNC and EOP generation, and must be used for high-speed packets only. It is provided for backward compatibility with legacy controllers that include SYNC and EOP bytes in the data payload when transmitting packets. The ISP1507x1 will not automatically generate the SYNC and EOP patterns when OPMODE[1:0] is set to 11b. The ISP1507x1 will still NRZI encode data and perform bit stuffing. An example of a sequence is shown in Figure 19. The link must always send packets using the TXCMD (NOPID) type. The ISP1507x1 does not provide a mechanism to control bit stuffing in individual bytes, but will automatically turn off bit stuffing for EOP when STP is asserted with data set to FEh. If data is set to 00h when STP is asserted, the

PHY will not transmit any EOP. The ISP1507x1 will also detect if the PID byte is A5h, indicating an SOF packet, and automatically send a long EOP when STP is asserted. To transmit chirp and resume signaling, the link must set OPMODE to 10b.
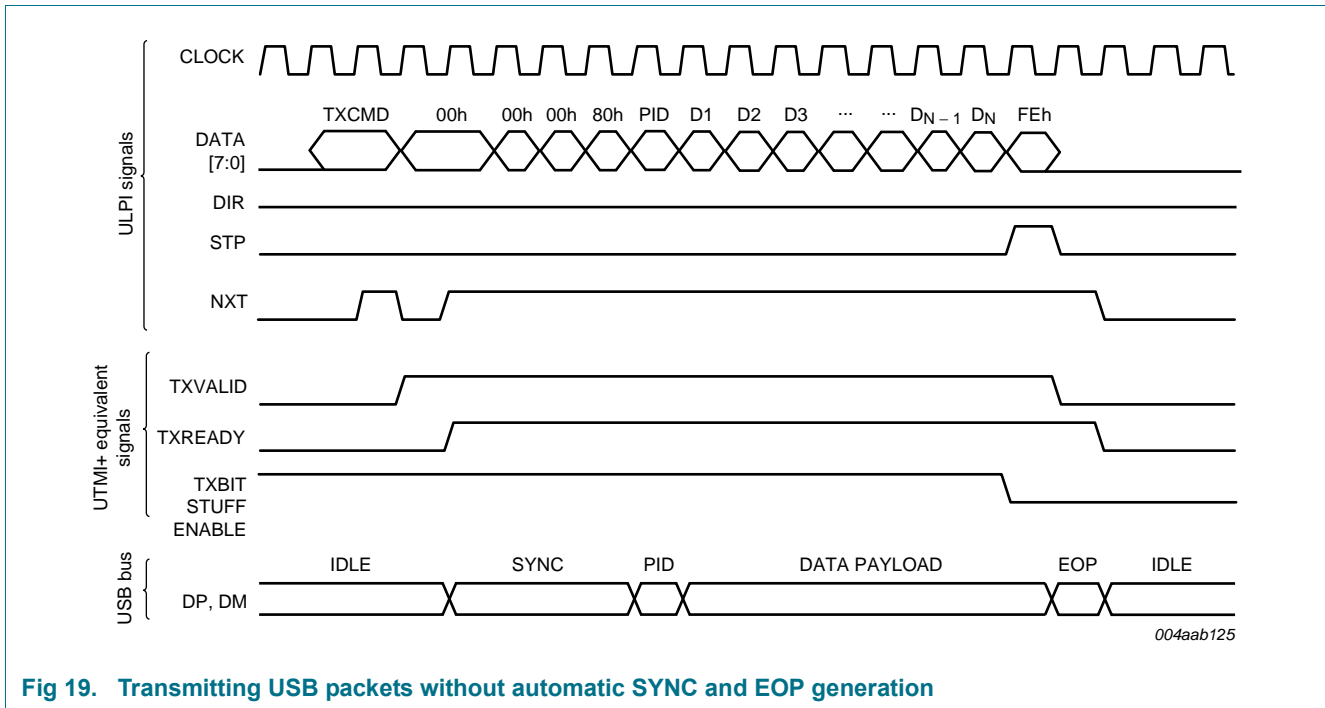
Fig 19. Transmitting USB packets without automatic SYNC and EOP generation

10.12 On-The-Go operations

On-The-Go (OTG) is a supplement to *Universal Serial Bus Specification Rev. 2.0* that allows a portable USB device to assume the role of a limited USB host by defining improvements, such as a small connector and low power. Non-portable devices, such as standard hosts and embedded hosts, can also benefit from OTG features.

The ISP1507x1 OTG PHY is designed to support all the tasks specified in the OTG supplement. The ISP1507x1 provides the front-end analog support for Host Negotiation Protocol (HNP) and Session Request Protocol (SRP) for dual-role devices. The supporting components include:

- Voltage comparators
  - A_VBUS_VLD
  - SESS_VLD (session valid, can be used for both A-session and B-session valid)
  - SESS_END (session end)
- Pull-up and pull-down resistors on DP and DM
- ID detector indicates if micro-A or micro-B plug is inserted
- Charge and discharge resistors on V_{BUS}

The following subsections describe how to use the ISP1507x1 OTG components.

10.12.1 OTG comparators

The ISP1507x1 provides comparators that conform to *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.3* requirements of $V_{A\_VBUS\_VLD}$, $V_{A\_SESS\_VLD}$, $V_{B\_SESS\_VLD}$, and $V_{B\_SESS\_END}$. In this data sheet, $V_{A\_SESS\_VLD}$ and $V_{B\_SESS\_VLD}$ are combined into $V_{B\_SESS\_VLD}$. Comparators are described in Section 8.6.2. Changes in comparator values are communicated to the link by RXCMDs as described in Section 10.5.2.2. Control over comparators is described in Section 11.1.5 to Section 11.1.8.

10.12.2 Pull-up and pull-down resistors

The USB resistors on DP and DM can be used to initiate data-line pulsing SRP. The link must set the required bus state using mode settings in Table 8.

10.12.3 ID detection

The ISP1507x1 provides an internal pull-up resistor to sense the value of the ID pin. The pull-up resistor must first be enabled by setting the ID_PULLUP register bit to logic 1. If the value on ID has changed, the ISP1507x1 will send an RXCMD or interrupt to the link by time t_{ID}. If the link does not receive any RXCMD or interrupt by t_{ID}, then the ID value has not changed.

10.12.4 V_{BUS} charge and discharge resistors

A pull-up resistor, $R_{UP(VBUS)}$, is provided to perform V_{BUS} pulsing SRP. A B-device is allowed to charge V_{BUS} above the session valid threshold to request the host to turn on the V_{BUS} power.

A pull-down resistor, $R_{DN(VBUS)}$, is provided for a B-device to discharge V_{BUS}. This is done whenever the A-device turns off the V_{BUS} power. The B-device can use the pull-down resistor to ensure V_{BUS} is below $V_{B\_SESS\_END}$ before starting a session.

For details, refer to *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.3*.

10.13 Serial modes

The ISP1507x1 supports both 6-pin serial mode and 3-pin serial mode, controlled by bits 6PIN_FSLS_SERIAL and 3PIN_FSLS_SERIAL of the INTF_CTRL register (see Section 11.1.3). For details, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1, Section 3.10*.

Figure 20 and Figure 21 provide examples of 6-pin serial mode and 3-pin serial mode, respectively.
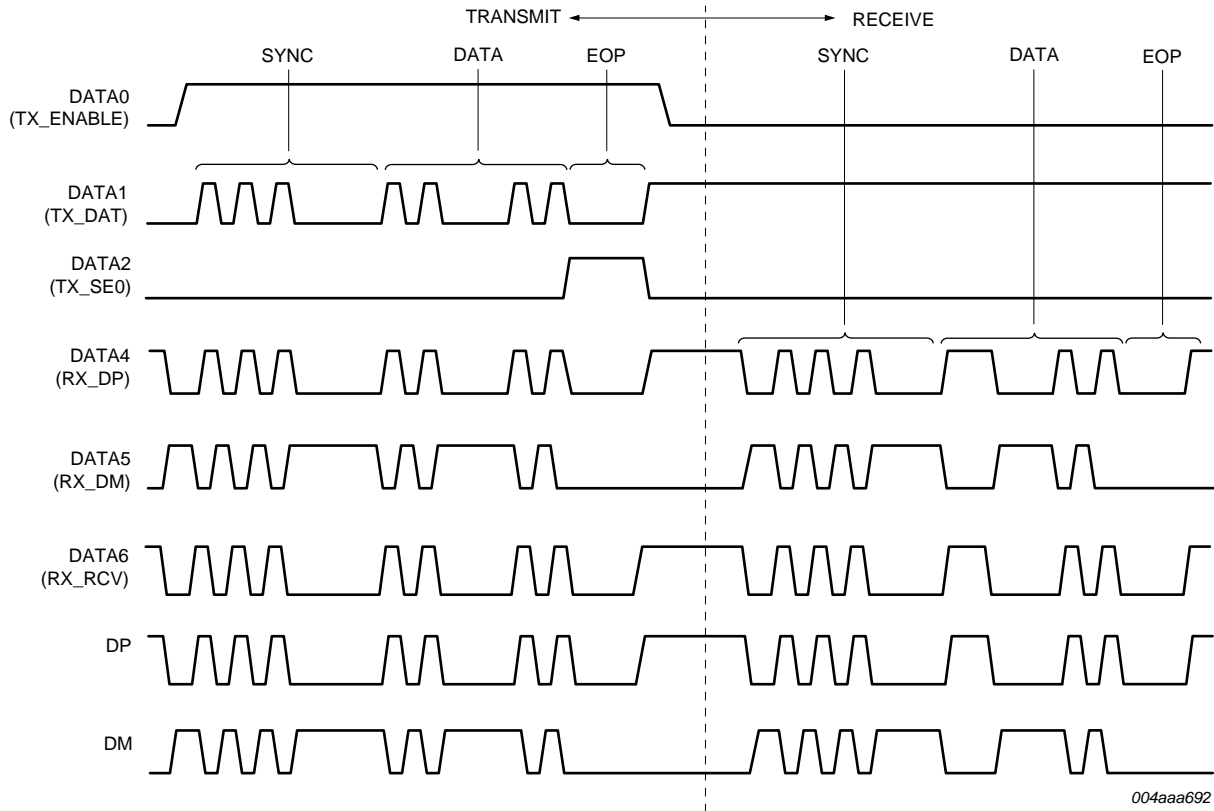
Fig 20. Example of transmit followed by receive in 6-pin serial mode
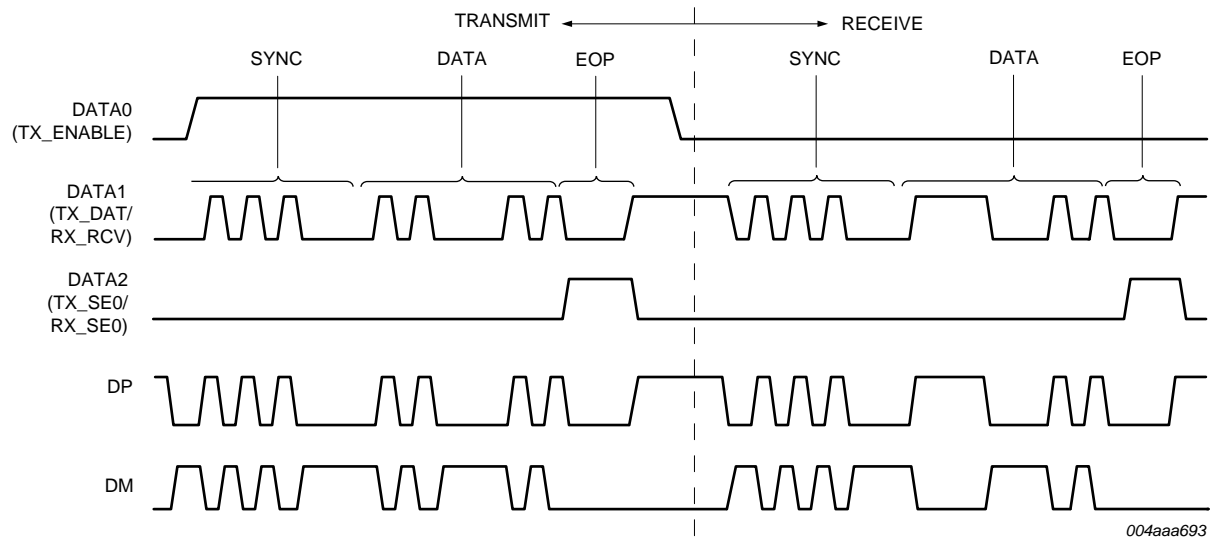
Fig 21. Example of transmit followed by receive in 3-pin serial mode

10.14 Aborting transfers

The ISP1507x1 supports aborting transfers on the ULPI bus. For details, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1, Section 3.8.4*.

10.15 Avoiding contention on the ULPI data bus

Because the ULPI data bus is bidirectional, avoid situations in which both the link and the PHY simultaneously drive the data bus.

The following points must be considered while implementing the data bus drive control on the link.

After power-up and clock stabilization, default states are as follows:

- The ISP1507x1 drives DIR to LOW.
- The data bus is input to the ISP1507x1.
- The ULPI link data bus is output, with all data bus lines driven to LOW.

When the ISP1507x1 wants to take control of the data bus to initiate a data transfer, it changes the DIR value from LOW to HIGH.

At this point, the link must disable its output buffers. This must be as fast as possible so the link must use a combinational path from DIR.

The ISP1507x1 will not immediately enable its output buffers, but will delay the enabling of its buffers until the next clock edge, avoiding bus contention.

When the data transfer is no longer required by the ISP1507x1, it changes DIR from HIGH to LOW and starts to immediately turn off its output drivers. The link senses the change of DIR from HIGH to LOW, but delays enabling its output buffers for one CLOCK cycle, avoiding data bus contention.

11. Register map

Table 19.   Immediate register set overview

Field name	Size (bit)	Address (6 bit)				References
		R[1]	W[2]	S[3]	C[4]	
VENDOR_ID_LOW	8	00h	-	-	-	Section 11.1.1 on page 49
VENDOR_ID_HIGH	8	01h	-	-	-	
PRODUCT_ID_LOW	8	02h	-	-	-	
PRODUCT_ID_HIGH	8	03h	-	-	-	
FUNC_CTRL	8	04h to 06h	04h	05h	06h	Section 11.1.2 on page 49
INTF_CTRL	8	07h to 09h	07h	08h	09h	Section 11.1.3 on page 50
OTG_CTRL	8	0Ah to 0Ch	0Ah	0Bh	0Ch	Section 11.1.4 on page 51
USB_INTR_EN_R_E	8	0Dh to 0Fh	0Dh	0Eh	0Fh	Section 11.1.5 on page 52
USB_INTR_EN_F_E	8	10h to 12h	10h	11h	12h	Section 11.1.6 on page 53
USB_INTR_STAT	8	13h	-	-	-	Section 11.1.7 on page 54
USB_INTR_L	8	14h	-	-	-	Section 11.1.8 on page 54
DEBUG	8	15h	-	-	-	Section 11.1.9 on page 55
SCRATCH	8	16h to 18h	16h	17h	18h	Section 11.1.10 on page 55
Reserved (do not use)	-	19h to 2Eh				Section 11.1.11 on page 55
Access extended register set	8	-	2Fh	-	-	Section 11.1.12 on page 55
Vendor-specific registers	8	30h to 3Ch				Section 11.1.13 on page 55
PWR_CTRL	8	3Dh to 3Fh				Section 11.1.14 on page 56

[1]   Read (R): A register can be read. Read-only if this is the only mode given.

[2]   Write (W): The pattern on the data bus will be written over all bits of a register.

[3]   Set (S): The pattern on the data bus is OR-ed with and written to a register.

[4]   Clear (C): The pattern on the data bus is a mask. If a bit in the mask is set, then the corresponding register bit will be set to zero (cleared).

Table 20.   Extended register set overview

Field name	Size (bit)	Address (6 bit)				References
		R[1]	W[2]	S[3]	C[4]	
Maps to immediate register set above	8	00h to 3Fh				Section 11.2 on page 56
Reserved (do not use)	8	40h to FFh				

[1]   Read (R): A register can be read. Read-only if this is the only mode given.

[2]   Write (W): The pattern on the data bus will be written over all bits of a register.

[3]   Set (S): The pattern on the data bus is OR-ed with and written to a register.

[4]   Clear (C): The pattern on the data bus is a mask. If a bit in the mask is set, then the corresponding register bit will be set to zero (cleared).

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11.1 Immediate register set

11.1.1 Vendor ID and product ID registers

11.1.1.1 VENDOR_ID_LOW register

Table 21 shows the bit description of the register.

Table 21. VENDOR_ID_LOW - Vendor ID Low register (address R = 00h) bit description
*Legend: * reset value*

Bit	Symbol	Access	Value	Description
7 to 0	VENDOR_ID_LOW[7:0]	R	CCh*	**Vendor ID low**: Lower byte of the ST-Ericsson vendor ID supplied by USB-IF; has a fixed value of CCh

11.1.1.2 VENDOR_ID_HIGH register

The bit description of the register is given in Table 22.

Table 22. VENDOR_ID_HIGH - Vendor ID High register (address R = 01h) bit description
*Legend: * reset value*

Bit	Symbol	Access	Value	Description
7 to 0	VENDOR_ID_HIGH[7:0]	R	04h*	**Vendor ID high**: Upper byte of the ST-Ericsson vendor ID supplied by USB-IF; has a fixed value of 04h

11.1.1.3 PRODUCT_ID_LOW register

The bit description of the PRODUCT_ID_LOW register is given in Table 23.

Table 23. PRODUCT_ID_LOW - Product ID Low register (address R = 02h) bit description
*Legend: * reset value*

Bit	Symbol	Access	Value	Description
7 to 0	PRODUCT_ID_LOW[7:0]	R	04h*	**Product ID low**: Lower byte of the ST-Ericsson product ID number; has a fixed value of 04h

11.1.1.4 PRODUCT_ID_HIGH register

The bit description of the register is given in Table 24.

Table 24. PRODUCT_ID_HIGH - Product ID High register (address R = 03h) bit description
*Legend: * reset value*

Bit	Symbol	Access	Value	Description
7 to 0	PRODUCT_ID_HIGH[7:0]	R	15h*	**Product ID high**: Upper byte of the ST-Ericsson product ID number; has a fixed value of 15h

11.1.2 FUNC_CTRL register

This register controls UTMI function settings of the ISP1507x1. The bit allocation of the register is given in Table 25.

Table 25. FUNC_CTRL - Function Control register (address R = 04h to 06h, W = 04h, S = 05h, C = 06h) bit allocation

Bit	7	6	5	4	3	2	1	0
Symbol	reserved	SUSPENDM	RESET	OPMODE[1:0]		TERM SELECT	XCVRSELECT[1:0]	
Reset	0	1	0	0	0	0	0	1
Access	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C

Table 26. FUNC_CTRL - Function Control register (address R = 04h to 06h, W = 04h, S = 05h, C = 06h) bit description

Bit	Symbol	Description
7	-	reserved
6	SUSPENDM	**Suspend LOW**: Active-LOW PHY suspend. Places the ISP1507x1 into low-power mode. The ISP1507x1 will power down all blocks, except the full-speed receiver, OTG comparators, and ULPI interface pins. To come out of low-power mode, the link must assert STP. The ISP1507x1 will automatically clear this bit when it exits low-power mode. **0b —** Low-power mode **1b —** Powered (default)
5	RESET	**Reset**: Active-HIGH transceiver reset. After the link sets this bit, the ISP1507x1 will assert DIR and reset the digital core. This does not reset the ULPI interface or the ULPI register set. When reset is completed, the ISP1507x1 will deassert DIR and automatically clear this bit, followed by an RXCMD update to the link. **0b —** Do not reset (default) **1b —** Reset The link must wait for DIR to deassert before using the ULPI bus. Does not reset the ULPI interface or the ULPI register set.
4 to 3	OPMODE[1:0]	**Operation mode**: Selects the required bit-encoding style during transmit. **00b —** Normal operation (default) **01b —** Non-driving **10b —** Disable bit-stuffing and NRZI encoding **11b —** Do not automatically add SYNC and EOP when transmitting; must be used only for high-speed packets
2	TERMSELECT	**Termination select**: Controls the internal 1.5 kΩ full-speed pull-up resistor and 45 Ω high-speed terminations. Control over bus resistors changes, depending on XCVRSELECT[1:0], OPMODE[1:0], DP_PULLDOWN, and DM_PULLDOWN, as shown in Table 8.
1 to 0	XCVRSELECT[1:0]	**Transceiver select**: Selects the required transceiver speed. **00b —** Enable the high-speed transceiver **01b —** Enable the full-speed transceiver (default) **10b —** Enable the low-speed transceiver **11b —** Enable the full-speed transceiver for low-speed packets (full-speed preamble is automatically prefixed)

11.1.3 INTF_CTRL register

The INTF_CTRL register enables alternative interfaces. All of these modes are optional features provided for legacy link cores. Setting more than one of these fields results in undefined behavior. Table 27 provides the bit allocation of the register.

Table 27. INTF_CTRL - Interface Control register (address R = 07h to 09h, W = 07h, S = 08h, C = 09h) bit allocation

Bit	7	6	5	4	3	2	1	0
Symbol	INTF_PROT_DIS	IND_PASS THRU	IND_COMPL	reserved	CLOCK_SUSPENDM	reserved	3PIN_FSLS_SERIAL	6PIN_FSLS_SERIAL
Reset	0	0	0	0	0	0	0	0
Access	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C

Table 28. **INTF_CTRL - Interface Control register (address R = 07h to 09h, W = 07h, S = 08h, C = 09h) bit description**

Bit	Symbol	Description
7	INTF_PROT_DIS	**Interface protect disable**: Controls circuitry built into the ISP1507x1 to protect the ULPI interface when the link 3-states STP and DATA[7:0]. When this bit is enabled, the ISP1507x1 will automatically detect when the link stops driving STP.
		0b — Enables the interface protect circuit (default). The ISP1507x1 attaches a weak pull-up resistor on STP. If STP is unexpectedly HIGH, the ISP1507x1 attaches weak pull-down resistors on DATA[7:0], protecting data inputs.
		1b — Disables the interface protect circuit, detaches weak pull-down resistors on DATA[7:0], and a weak pull-up resistor on STP.
6	IND_PASSTHRU	**Indicator pass-through**: Controls whether the complement output is qualified with the internal A_VBUS_VLD comparator before being used in the V_{BUS} state in RXCMD. For details, see Section 10.5.2.2.
		0b — The complement output signal is qualified with the internal A_VBUS_VLD comparator (default).
		1b — The complement output signal is not qualified with the internal A_VBUS_VLD comparator.
5	IND_COMPL	**Indicator complement**: Informs the ISP1507x1 to invert the FAULT input signal, generating the complement output. For details, see Section 10.5.2.2.
		0b — The ISP1507x1 will not invert the FAULT signal (default).
		1b — The ISP1507x1 will invert the FAULT signal.
4	-	reserved
3	CLOCK_SUSPENDM	**Clock suspend LOW**: Active-LOW clock suspend.
		Powers down the internal clock circuitry only. By default, the clock will not be powered in 6-pin serial mode or 3-pin serial mode.
		Valid only in 6-pin serial mode and 3-pin serial mode. Valid only when SUSPENDM is set to logic 1, otherwise this bit is ignored.
		0b — Clock will not be powered in 3-pin or 6-pin serial mode (default).
		1b — Clock will be powered in 3-pin and 6-pin serial mode.
2	-	reserved
1	3PIN_FSLS_SERIAL	**3-pin full-speed low-speed serial mode**: Changes the ULPI interface to a 3-bit serial interface. The ISP1507x1 will automatically clear this bit when 3-pin serial mode is exited.
		0b — Full-speed or low-speed packets are sent using the parallel interface (default).
		1b — Full-speed or low-speed packets are sent using the 3-pin serial interface.
0	6PIN_FSLS_SERIAL	**6-pin full-speed low-speed serial mode**: Changes the ULPI interface to a 6-bit serial interface. The ISP1507x1 will automatically clear this bit when 6-pin serial mode is exited.
		0b — Full-speed or low-speed packets are sent using the parallel interface (default).
		1b — Full-speed or low-speed packets are sent using the 6-pin serial interface.

11.1.4 OTG_CTRL register

This register controls various OTG functions of the ISP1507x1. The bit allocation of the OTG_CTRL register is given in Table 29.

Table 29. OTG_CTRL - OTG Control register (address R = 0Ah to 0Ch, W = 0Ah, S = 0Bh, C = 0Ch) bit allocation

Bit	7	6	5	4	3	2	1	0
Symbol	USE_EXT_VBUS_IND	DRV_VBUS_EXT	reserved	CHRG_VBUS	DISCHRG_VBUS	DM_PULL DOWN	DP_PULL DOWN	ID_PULL UP
Reset	0	0	0	0	0	1	1	0
Access	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C

Table 30. OTG_CTRL - OTG Control register (address R = 0Ah to 0Ch, W = 0Ah, S = 0Bh, C = 0Ch) bit description

Bit	Symbol	Description
7	USE_EXT_VBUS_IND	**Use external V_{BUS} indicator**: Informs the ISP1507x1 to use an external V_{BUS} overcurrent indicator. **0b —** Use the internal OTG comparator (default). **1b —** Use the external V_{BUS} valid indicator signal input from the FAULT pin.
6	DRV_VBUS_EXT	**Drive V_{BUS} external**: Controls the external charge pump or 5 V by the PSW_N pin. **0b —** PSW_N is HIGH (default). **1b —** PSW_N is LOW.
5	-	reserved
4	CHRG_VBUS	**Charge V_{BUS}**: Charges V_{BUS} through a resistor. Used for the V_{BUS} pulsing SRP. The link must first check that V_{BUS} is discharged (see bit DISCHRG_VBUS), and that both the DP and DM data lines have been LOW (SE0) for 2 ms. **0b —** Do not charge V_{BUS} (default). **1b —** Charge V_{BUS}.
3	DISCHRG_VBUS	**Discharge V_{BUS}**: Discharges V_{BUS} through a resistor. If the link sets this bit to logic 1, it waits for an RXCMD indicating that SESS_END has changed from 0 to 1, and then resets this bit to 0 to stop the discharge. **0b —** Do not discharge V_{BUS} (default). **1b —** Discharge V_{BUS}.
2	DM_PULLDOWN	**DM pull down**: Enables the 15 kΩ pull-down resistor on DM. **0b —** Pull-down resistor is not connected to DM. **1b —** Pull-down resistor is connected to DM (default).
1	DP_PULLDOWN	**DP pull down**: Enables the 15 kΩ pull-down resistor on DP. **0b —** Pull-down resistor is not connected to DP. **1b —** Pull-down resistor is connected to DP (default).
0	ID_PULLUP	**ID pull up**: Connects a pull-up to the ID line and enables sampling of the ID level. Disabling the ID line sampler will reduce ISP1507x1 power consumption. **0b —** Disables sampling of the ID line (default). **1b —** Enables sampling of the ID line.

11.1.5 USB_INTR_EN_R_E register

The bits in this register enable interrupts and RXCMDs to be sent when the corresponding bits in the USB_INTR_STAT register change from logic 0 to logic 1. By default, all transitions are enabled. Table 31 shows the bit allocation of the register.

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Table 31. USB_INTR_EN_R_E - USB Interrupt Enable Rising Edge register (address R = 0Dh to 0Fh, W = 0Dh, S = 0Eh, C = 0Fh) bit allocation

Bit	7	6	5	4	3	2	1	0
Symbol		reserved		ID_GND_R	SESS_END_R	SESS_VALID_R	VBUS_VALID_R	HOST_DISCON_R
Reset	0	0	0	1	1	1	1	1
Access	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C

Table 32. USB_INTR_EN_R_E - USB Interrupt Enable Rising Edge register (address R = 0Dh to 0Fh, W = 0Dh, S = 0Eh, C = 0Fh) bit description

Bit	Symbol	Description
7 to 5	-	reserved
4	ID_GND_R	**ID ground rise**: Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on ID_GND.
3	SESS_END_R	**Session end rise**: Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on SESS_END.
2	SESS_VALID_R	**Session valid rise**: Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on SESS_VLD.
1	VBUS_VALID_R	V_{BUS} **valid rise**: Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on A_VBUS_VLD.
0	HOST_DISCON_R	**Host disconnect rise**: Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on HOST_DISCON.

11.1.6 USB_INTR_EN_F_E register

The bits in this register enable interrupts and RXCMDs to be sent when the corresponding bits in the USB_INTR_STAT register change from logic 1 to logic 0. By default, all transitions are enabled. See Table 33.

Table 33. USB_INTR_EN_F_E - USB Interrupt Enable Falling Edge register (address R = 10h to 12h, W = 10h, S = 11h, C = 12h) bit allocation

Bit	7	6	5	4	3	2	1	0
Symbol		reserved		ID_GND_F	SESS_END_F	SESS_VALID_F	VBUS_VALID_F	HOST_DISCON_F
Reset	0	0	0	1	1	1	1	1
Access	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C

Table 34. USB_INTR_EN_F_E - USB Interrupt Enable Falling Edge register (address R = 10h to 12h, W = 10h, S = 11h, C = 12h) bit description

Bit	Symbol	Description
7 to 5	-	reserved
4	ID_GND_F	**ID ground fall**: Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on ID_GND.
3	SESS_END_F	**Session end fall**: Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on SESS_END.
2	SESS_VALID_F	**Session valid fall**: Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on SESS_VLD.
1	VBUS_VALID_F	V_{BUS} **valid fall**: Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on A_VBUS_VLD.
0	HOST_DISCON_F	**Host disconnect fall**: Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on HOST_DISCON.

11.1.7 USB_INTR_STAT register

This register (see Table 35) indicates the current value of the interrupt source signal.

Table 35.   USB_INTR_STAT - USB Interrupt Status register (address R = 13h) bit allocation

Bit	7	6	5	4	3	2	1	0
Symbol	reserved			ID_GND	SESS_END	SESS_ VALID	VBUS_ VALID	HOST_ DISCON
Reset	X	X	X	0	0	0	0	0
Access	R	R	R	R	R	R	R	R

Table 36.   USB_INTR_STAT - USB Interrupt Status register (address R = 13h) bit description

Bit	Symbol	Description
7 to 5	-	reserved
4	ID_GND	**ID ground**: Reflects the current value of the ID detector circuit.
3	SESS_END	**Session end**: Reflects the current value of the session end voltage comparator.
2	SESS_VALID	**Session valid**: Reflects the current value of the session valid voltage comparator.
1	VBUS_VALID	**V$_{BUS}$ valid**: Reflects the current value of the V$_{BUS}$ valid voltage comparator.
0	HOST_DISCON	**Host disconnect**: Reflects the current value of the host disconnect detector.

11.1.8 USB_INTR_L register

The bits of the USB_INTR_L register are automatically set by the ISP1507x1 when an unmasked change occurs on the corresponding interrupt source signal. The ISP1507x1 will automatically clear all bits when the link reads this register, or when the PHY enters low-power or serial mode.

Remark: It is optional for the link to read this register when the clock is running because all signal information will automatically be sent to the link through the RXCMD byte.

The bit allocation of this register is given in Table 37.

Table 37.   USB_INTR_L - USB Interrupt Latch register (address R = 14h) bit allocation

Bit	7	6	5	4	3	2	1	0
Symbol	reserved			ID_GND_L	SESS_ END_L	SESS_ VALID_L	VBUS_ VALID_L	HOST_ DISCON_L
Reset	0	0	0	0	0	0	0	0
Access	R	R	R	R	R	R	R	R

Table 38.   USB_INTR_L - USB Interrupt Latch register (address R = 14h) bit description

Bit	Symbol	Description
7 to 5	-	reserved
4	ID_GND_L	**ID ground latch**: Automatically set when an unmasked event occurs on ID_GND. Cleared when this register is read.
3	SESS_END_L	**Session end latch**: Automatically set when an unmasked event occurs on SESS_END. Cleared when this register is read.

Table 38. USB_INTR_L - USB Interrupt Latch register (address R = 14h) bit description …*continued*

Bit	Symbol	Description
2	SESS_VALID_L	**Session valid latch**: Automatically set when an unmasked event occurs on SESS_VLD. Cleared when this register is read.
1	VBUS_VALID_L	**V$_{BUS}$ valid latch**: Automatically set when an unmasked event occurs on A_VBUS_VLD. Cleared when this register is read.
0	HOST_DISCON_L	**Host disconnect latch**: Automatically set when an unmasked event occurs on HOST_DISCON. Cleared when this register is read.

11.1.9 DEBUG register

The bit allocation of the DEBUG register is given in Table 39. This register indicates the current value of signals useful for debugging.

Table 39. DEBUG - Debug register (address R = 15h) bit allocation

Bit	7	6	5	4	3	2	1	0
Symbol	reserved						LINE STATE1	LINE STATE0
Reset	0	0	0	0	0	0	0	0
Access	R	R	R	R	R	R	R	R

Table 40. DEBUG - Debug register (address R = 15h) bit description

Bit	Symbol	Description
7 to 2	-	reserved
1	LINESTATE1	**Line state 1**: Contains the current value of LINESTATE 1.
0	LINESTATE0	**Line state 0**: Contains the current value of LINESTATE 0.

11.1.10 SCRATCH register

This is an empty register for testing purposes; see Table 41.

Table 41. SCRATCH - Scratch register (address R = 16h to 18h, W = 16h, S = 17h, C = 18h) bit description
*Legend: * reset value*

Bit	Symbol	Access	Value	Description
7 to 0	SCRATCH [7:0]	R/W/S/C	00h*	**Scratch**: This is an empty register byte for testing purposes. Software can read, write, set, and clear this register. The functionality of the ISP1507x1 will not be affected.

11.1.11 Reserved

Registers 19h to 2Eh are not implemented. Operating on these addresses will have no effect on the ISP1507x1.

11.1.12 Access extended register set

Address 2Fh does not contain register data. Instead it links to the extended register set. The immediate register set maps to the lower end of the extended register set.

11.1.13 Vendor-specific registers

Addresses 30h to 3Fh contain vendor-specific registers.

11.1.14 PWR_CTRL register

This register controls various aspects of the ISP1507x1. See Table 42.

Table 42. **PWR_CTRL - Power Control register (address R = 3Dh to 3Fh, W = 3Dh, S = 3Eh, C = 3Fh) bit allocation**

Bit	7	6	5	4	3	2	1	0
Symbol	reserved				BVALID_FALL	BVALID_RISE	reserved	
Reset	0	0	0	0	0	0	0	0
Access	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C	R/W/S/C

Table 43. **PWR_CTRL - Power Control register (address R = 3Dh to 3Fh, W = 3Dh, S = 3Eh, C = 3Fh) bit description**

Bit	Symbol	Description
7 to 4	-	reserved; the link must never write logic 1 to these bits.
3	BVALID_FALL	**BVALID fall**: Enables RXCMDs for HIGH-to-LOW transitions on BVALID. When BVALID changes from HIGH to LOW, the ISP1507x1 will send an RXCMD to the link with the ALT_INT bit set to logic 1. This bit is optional and is not necessary for OTG devices. This bit is provided for debugging purposes. The session valid comparator should be used instead.
2	BVALID_RISE	**BVALID rise**: Enables RXCMDs for LOW-to-HIGH transitions on BVALID. When BVALID changes from LOW to HIGH, the ISP1507x1 will send an RXCMD to the link with the ALT_INT bit set to logic 1. This bit is optional and is not necessary for OTG devices. This bit is provided for debugging purposes. The session valid comparator should be used instead.
1 to 0	-	reserved; the link must never write logic 1 to these bits.

11.2 Extended register set

Addresses 00h to 3Fh of the extended register set directly map to the immediate set. This means a read, write, set, or clear operation to these extended addresses will operate on the immediate register set.

Addresses 40h to FFh are not implemented. Operating on these addresses may result in undefined behavior of the PHY.

12. ElectroStatic Discharge (ESD)

12.1 ESD protection

The pins that are connected to the USB connector (DP, DM, ID, V_{BUS}, and GND) have a minimum of ± 4 kV ESD protection. Capacitors 0.1 μF and 1 μF must be connected in parallel from V_{BUS} to GND to achieve this ± 4 kV ESD protection (see Figure 22).

Remark: Capacitors 0.1 μF and 1 μF are also required by *Universal Serial Bus Specification Rev. 2.0*. For details on the requirements for C_{VBUS}, see Section 17.
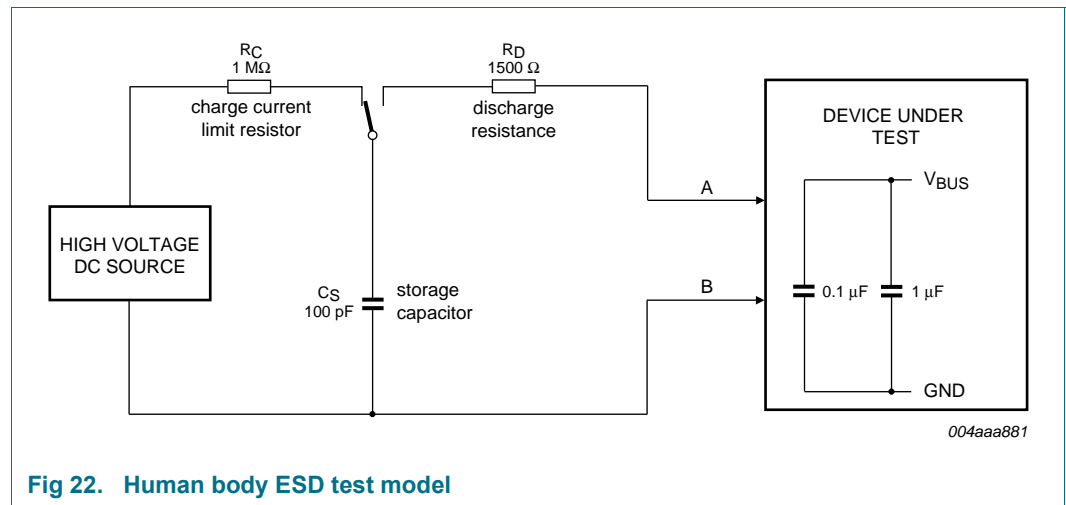
Fig 22. Human body ESD test model

12.2 ESD test conditions

A detailed report on test set up and results is available on request.

13. Limiting values

Table 44.   Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			−0.5	+4.6	V
$V_{CC(I/O)}$	input/output supply voltage			−0.5	+4.6	V
V_I	input voltage	on pins STP, DATA[7:0], RESET_N, and CHIP_SELECT_N		−0.5	$V_{CC(I/O)}$ + 0.5[1][2][3]	V
		on pins V_{BUS}, FAULT, and PSW_N		−0.5	+6.0	V
		on pin XTAL1		−0.5	+2.5	V
		on pin ID		−0.5	+4.6	V
		on pins DP and DM	[4]	−0.5	+4.6	V
V_{ESD}	electrostatic discharge voltage	pins DP, DM, ID, V_{BUS}, and GND; I_{LI} < 1 µA	[5]	−4	+4	kV
		all other pins; I_{LI} < 1 µA	[5]	−1.5	+1.5	kV
I_{lu}	latch-up current	−0.5 × V_{CC} < V < +1.5 × V_{CC}		-	100	mA
T_{stg}	storage temperature			−40	+125	°C

[1]   Maximum value may not exceed 4.6 V.

[2]   Includes voltage on outputs in 3-state mode.

[3]   Only valid when the $V_{CC(I/O)}$ supply voltage is present.

[4]   The ISP1507x1 has been tested according to the additional requirements listed in *Universal Serial Bus Specification Rev. 2.0, Section 7.1.1*. The short circuit withstand test and the AC stress test were performed for 24 hours, and the ISP1507x1 was found to be fully operational after the test completed.

[5]   Equivalent to discharging a 100 pF capacitor through a 1.5 kΩ resistor (Human Body Model JESD22-A114D).

14. Recommended operating conditions

Table 45.   Recommended operating conditions

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{CC}	supply voltage			3.0	3.3	3.6	V
$V_{CC(I/O)}$	input/output supply voltage		[1]	1.65	-	3.6	V
V_I	input voltage	on pins STP, DATA[7:0], RESET_N, and CHIP_SELECT_N		0	-	$V_{CC(I/O)}$	V
		on pins V_{BUS}, FAULT, and PSW_N		0	-	5.5	V
		on pins DP, DM, and ID		0	-	3.6	V
		on pin XTAL1		0	-	1.95	V
T_{amb}	ambient temperature			−40	+25	+85	°C
T_j	junction temperature			−40	-	+125	°C

[1] $V_{CC(I/O)}$ must be less than or equal to V_{CC}.

15. Static characteristics

Table 46.   Static characteristics: supply pins

V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(REG3V3)}$	voltage on pin REG3V3		3.0	3.3	3.6	V
$V_{(REG1V8)}$	voltage on pin REG1V8		1.65	1.8	1.95	V
$V_{POR(trip)}$	power-on reset trip voltage		1.0	-	1.5	V
I_{CC}	supply current	high-speed idle; no USB activity	-	31	-	mA
		low-power mode; V_{BUS} valid detector disabled; 1.5 kΩ pull-up resistor on pin DP disconnected	-	35	160[1]	μA
		low-power mode; V_{BUS} valid detector disabled; 1.5 kΩ pull-up resistor on pin DP connected	-	215	280	μA
		full-speed continuous data transmit; 50 pF load on pins DP and DM [2]	-	15	-	mA
		full-speed continuous data receive [2]	-	11	-	mA
		high-speed continuous data transmit; 45 Ω load on pins DP and DM to ground [2]	-	48	-	mA
		high-speed continuous data receive [2]	-	28	-	mA
$I_{CC(I/O)}$	supply current on pin $V_{CC(I/O)}$	ULPI interface pins are static	-	-	1	μA

[1]   Value observed at −40 °C only.

[2]   A continuous stream of 1 kB packets with minimum inter-packet gap and all data bits set to logic 0 for continuous toggling.

Table 47.   Static characteristics: digital pins

Digital pins: CLOCK, DIR, STP, NXT, DATA[7:0], RESET_N, and CHIP_SELECT_N; unless otherwise specified.
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Input levels						
V_{IL}	LOW-level input voltage		-	-	$0.3 \times V_{CC(I/O)}$	V
V_{IH}	HIGH-level input voltage		$0.7 \times V_{CC(I/O)}$	-	-	V
I_{IL}	LOW-level input current	V_I = 0 V	-	-	1	μA
I_{IH}	HIGH-level input current	V_I = $V_{CC(I/O)}$	-	-	1	μA
I_{LI}	input leakage current		−1	+0.1	+1	μA
Output levels						
V_{OH}	HIGH-level output voltage	I_{OH} = −2 mA	$V_{CC(I/O)}$ − 0.2	-	-	V
V_{OL}	LOW-level output voltage	I_{OL} = +2 mA	-	-	0.2	V
I_{OH}	HIGH-level output current	V_O = $V_{CC(I/O)}$ − 0.4 V	−2	-	-	mA
I_{OL}	LOW-level output current	V_O = 0.4 V	+2	-	-	mA
I_{OZ}	off-state output current	0 V < V_O < $V_{CC(I/O)}$	-	-	1	μA
Impedance						
Z_L	load impedance		45	-	65	Ω

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Table 47.   Static characteristics: digital pins *…continued*
Digital pins: CLOCK, DIR, STP, NXT, DATA[7:0], RESET_N, and CHIP_SELECT_N; unless otherwise specified.
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 ℃ to +85 ℃; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 ℃; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Pull-up and pull-down						
I_{pd}	pull-down current	interface protect enabled; DATA[7:0] pins only; $V_I = V_{CC(I/O)}$	25	50	90	μA
I_{pu}	pull-up current	interface protect enabled; STP pin only; V_I = 0 V	−30	−50	−80	μA
Capacitance						
C_{in}	input capacitance	pins STP, RESET_N, DATA[7:0], and CHIP_SELECT_N	-	-	3.5	pF

Table 48.   Static characteristics: digital pin FAULT
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 ℃ to +85 ℃; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 ℃; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Input levels						
V_{IL}	LOW-level input voltage		-	-	0.8	V
V_{IH}	HIGH-level input voltage		2.0	-	-	V
I_{IL}	LOW-level input current	V_I = 0 V	-	-	1	μA
I_{IH}	HIGH-level input current	$V_I = V_{CC(I/O)}$	-	-	1	μA

Table 49.   Static characteristics: digital pin PSW_N
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 ℃ to +85 ℃; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Output levels						
V_{OH}	HIGH-level output voltage	external pull-up resistor connected	-	-	5.5	V
V_{OL}	LOW-level output voltage	I_{OL} = −4 mA	-	-	0.4	V
I_{OH}	HIGH-level output current	external pull-up resistor connected	-	-	1	μA
I_{OL}	LOW-level output current	V_O = 0.4 V	4.0	-	-	mA

Table 50.   Static characteristics: analog I/O pins (DP, DM)
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 ℃ to +85 ℃; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 ℃; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Original USB transceiver (low-speed and full-speed)						
Input levels (differential receiver)						
V_{DI}	differential input sensitivity voltage	$|V_{DP} − V_{DM}|$	0.2	-	-	V
V_{CM}	differential common mode voltage range	includes V_{DI} range	0.8	-	2.5	V
Input levels (single-ended receivers)						
V_{IL}	LOW-level input voltage		-	-	0.8	V
V_{IH}	HIGH-level input voltage		2.0	-	-	V

Table 50. Static characteristics: analog I/O pins (DP, DM) *…continued*

V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Output levels						
V_{OL}	LOW-level output voltage	pull-up on pin DP; R_L = 1.5 kΩ to 3.6 V	0.0	0.18	0.3	V
V_{OH}	HIGH-level output voltage	pull-down on pins DP and DM; R_L = 15 kΩ to GND	2.8	3.2	3.6	V
Termination						
V_{TERM}	termination voltage for upstream facing port pull-up	for 1.5 kΩ pull-up resistor	3.0	-	3.6	V
Resistance						
$R_{UP(DP)}$	pull-up resistance on pin DP		1425	1500	1575	Ω
High-speed USB transceiver						
Input levels (differential receiver)						
V_{HSSQ}	high-speed squelch detection threshold voltage (differential signal amplitude)		100	-	150	mV
V_{HSDSC}	high-speed disconnect detection threshold voltage (differential signal amplitude)		525	-	625	mV
V_{HSDI}	high-speed differential input sensitivity	$|V_{DP} − V_{DM}|$	100	-	-	mV
V_{HSCM}	high-speed data signaling common mode voltage range (guideline for receiver)	includes V_{DI} range	−50	-	+500	mV
V_{HSOI}	high-speed idle level voltage		−10	-	+10	mV
V_{HSOL}	high-speed data signaling LOW-level voltage		−10	-	+10	mV
Output levels						
V_{HSOH}	high-speed data signaling HIGH-level voltage		360	-	440	mV
V_{CHIRPJ}	Chirp J level (differential voltage)		700	-	1100	mV
V_{CHIRPK}	Chirp K level (differential voltage)		−900	-	−500	mV
Leakage current						
I_{LZ}	off-state leakage current		−1	-	+1	µA
Capacitance						
C_{in}	input capacitance	pin to GND	-	-	5	pF
Resistance						
$R_{DN(DP)}$	pull-down resistance on pin DP		14.25	15	15.75	kΩ
$R_{DN(DM)}$	pull-down resistance on pin DM		14.25	15	15.75	kΩ

Table 50. Static characteristics: analog I/O pins (DP, DM) *…continued*
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Termination							
$Z_{O(drv)(DP)}$	driver output impedance on pin DP	steady-state drive	[1]	40.5	45	49.5	Ω
$Z_{O(drv)(DM)}$	driver output impedance on pin DM	steady-state drive	[1]	40.5	45	49.5	Ω
Z_{INP}	input impedance exclusive of pull-up/pull-down (for low-/full-speed)			10	-	-	MΩ

[1] For high-speed USB and full-speed USB.

Table 51. Static characteristics: V_{BUS} comparators
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{A\_VBUS\_VLD}$	A-device V_{BUS} valid voltage		-	4.6	-	V
$V_{B\_SESS\_VLD}$	B-device session valid voltage	for A-device and B-device	0.8	1.6	2.0	V
$V_{hys(B\_SESS\_VLD)}$	B-device session valid hysteresis voltage		70	90	110	mV
$V_{B\_SESS\_END}$	B-device session end voltage		0.2	0.5	0.8	V

Table 52. Static characteristics: V_{BUS} resistors
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{UP(VBUS)}$	pull-up resistance on pin V_{BUS}	connect to pin REG3V3 when CHRG_VBUS is logic 1	281	680	-	Ω
$R_{DN(VBUS)}$	pull-down resistance on pin V_{BUS}	connect to GND when DISCHRG_VBUS is logic 1	656	1100	-	Ω
$R_{I(idle)(VBUS)(A)}$	idle input resistance on pin V_{BUS} (A-device)	ID pin is LOW	40	57	80	kΩ
$R_{I(idle)(VBUS)(B)}$	idle input resistance on pin V_{BUS} (B-device)	ID pin is HIGH	170	240	310	kΩ

Table 53. Static characteristics: ID detection circuit
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_{ID}	ID detection time		50	-	-	ms
$V_{th(ID)}$	ID detector threshold voltage		0.8	1.2	2.0	V
$R_{UP(ID)}$	ID pull-up resistance	ID_PULLUP is logic 1	40	50	60	kΩ

Table 54. Static characteristics: resistor reference
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{O(RREF)}$	output voltage on pin RREF	SUSPENDM is logic 1	-	1.22	-	V

16. Dynamic characteristics

Table 55. Dynamic characteristics: reset and clock

V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Reset						
$t_{W(POR)}$	internal power-on reset pulse width		0.2	-	-	µs
$t_{w(REG1V8\_H)}$	REG1V8 HIGH pulse width		2	-	-	µs
$t_{w(REG1V8\_L)}$	REG1V8 LOW pulse width		11	-	-	µs
$t_{W(RESET\_N)}$	external RESET_N pulse width		200	-	-	ns
t_{REGUP}	regulator start-up time	4.7 µF ± 20% capacitor each on pins REG1V8 and REG3V3				
		V_{CC} = 3.3 V; T_{amb} = +25 °C	-	2	-	ms
		V_{CC} = 3.0 V; T_{amb} = −40 °C	-	-	50	ms
Crystal or clock applied to XTAL1						
$f_{i(XTAL1)}$	input frequency on pin XTAL1	ISP1507A1	-	19.2	-	MHz
		ISP1507B1	-	26	-	MHz
$t_{jit(i)(XTAL1)(c-c)}$	peak-to-peak, cycle-to-cycle input jitter on pin XTAL1		-	-	200	ps
$\delta_{i(XTAL1)}$	input duty cycle on pin XTAL1	applicable only when clock is applied on pin XTAL1 [1]	-	50	-	%
$\Delta f_{i(XTAL1)}$	input frequency tolerance on pin XTAL1		-	50	200	ppm
$t_{r(XTAL1)}$	rise time on pin XTAL1	only for square wave input	-	-	5	ns
$t_{f(XTAL1)}$	fall time on pin XTAL1	only for square wave input	-	-	5	ns
$V_{(XTAL1)(p-p)}$	peak-to-peak voltage on pin XTAL1	only for square wave input	0.566	-	1.95	V
Output CLOCK characteristics						
$f_{o(CLOCK)}$	output frequency on pin CLOCK		-	60	-	MHz
$t_{jit(o)(CLOCK)RMS}$	RMS output jitter on pin CLOCK		-	-	500	ps
$\delta_{o(CLOCK)}$	output clock duty cycle on pin CLOCK		45	50	55	%
$t_{startup(PLL)}$	PLL startup time		-	650	-	µs
$t_{startup(o)(CLOCK)}$	output CLOCK start-up time	measured from power good or assertion of pin STP	450	650	900	µs

[1] The internal PLL is triggered only on the positive edge from the crystal oscillator. Therefore, the duty cycle is not critical.

Table 56. Dynamic characteristics: digital I/O pins

V_{CC} = 3.0 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CC(I/O)}$ = 1.65 V to 1.95 V						
$t_{su(DATA)}$	DATA set-up time with respect to the rising edge of pin CLOCK	20 pF total external load per pin	5.7	-	-	ns
$t_{h(DATA)}$	DATA hold time with respect to the rising edge of pin CLOCK	20 pF total external load per pin	0	-	-	ns
$t_{d(DATA)}$	DATA output delay with respect to the rising edge of pin CLOCK	20 pF total external load per pin	-	-	7.8	ns
$t_{su(STP)}$	STP set-up time with respect to the rising edge of pin CLOCK	20 pF total external load per pin	4.5	-	-	ns
$t_{h(STP)}$	STP hold time with respect to the rising edge of pin CLOCK	20 pF total external load per pin	0	-	-	ns
$t_{d(DIR)}$	DIR output delay with respect to the rising edge of pin CLOCK	20 pF total external load per pin	-	-	8.9	ns
$t_{d(NXT)}$	NXT output delay with respect to the rising edge of pin CLOCK	20 pF total external load per pin	-	-	8.9	ns
$V_{CC(I/O)}$ = 3.0 V to 3.6 V						
$t_{su(DATA)}$	DATA set-up time with respect to the rising edge of pin CLOCK	30 pF total external load per pin	3.3	-	-	ns
$t_{h(DATA)}$	DATA hold time with respect to the rising edge of pin CLOCK	30 pF total external load per pin	0.8	-	-	ns
$t_{d(DATA)}$	DATA output delay with respect to the rising edge of pin CLOCK	30 pF total external load per pin	-	-	5.5	ns
$t_{su(STP)}$	STP set-up time with respect to the rising edge of pin CLOCK	30 pF total external load per pin	3.4	-	-	ns
$t_{h(STP)}$	STP hold time with respect to the rising edge of pin CLOCK	30 pF total external load per pin	0.8	-	-	ns
$t_{d(DIR)}$	DIR output delay with respect to the rising edge of pin CLOCK	30 pF total external load per pin	-	-	6.6	ns
$t_{d(NXT)}$	NXT output delay with respect to the rising edge of pin CLOCK	30 pF total external load per pin	-	-	6.6	ns

Table 57. Dynamic characteristics: analog I/O pins (DP and DM)

V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
High-speed driver						
t_{HSR}	rise time (10% to 90%)		500	-	-	ps
t_{HSF}	fall time (10% to 90%)		500	-	-	ps
Full-speed driver						
t_{FR}	rise time	C_L = 50 pF; 10% to 90% of $\|V_{OH} - V_{OL}\|$	4	-	20	ns
t_{FF}	fall time	C_L = 50 pF; 10% to 90% of $\|V_{OH} - V_{OL}\|$	4	-	20	ns
t_{FRFM}	differential rise and fall time matching	excluding the first transition from the idle state	90	-	111.1	%

Table 57. **Dynamic characteristics: analog I/O pins (DP and DM)** *…continued*
V_{CC} = 3.0 V to 3.6 V; $V_{CC(I/O)}$ = 1.65 V to 3.6 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified.
Typical values are at V_{CC} = 3.3 V; $V_{CC(I/O)}$ = 3.3 V; T_{amb} = +25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CRS}	output signal crossover voltage	excluding the first transition from the idle state	1.3	-	2.0	V
Low-speed driver						
t_{LR}	transition time: rise time	C_L = 200 pF to 600 pF; 1.5 kΩ pull-up on pin DM enabled; 10% to 90% of $|V_{OH} − V_{OL}|$	75	-	300	ns
t_{LF}	transition time: fall time	C_L = 200 pF to 600 pF; 1.5 kΩ pull-up on pin DM enabled; 10% to 90% of $|V_{OH} − V_{OL}|$	75	-	300	ns
t_{LRFM}	rise and fall time matching	t_{LR}/t_{LF}; excluding the first transition from the idle state	80	-	125	%
Driver timing						
$t_{PLH(drv)}$	driver propagation delay (LOW to HIGH)	TX_DAT, TX_SE0 to DP, DM; see Figure 24	-	-	20	ns
$t_{PHL(drv)}$	driver propagation delay (HIGH to LOW)	TX_DAT, TX_SE0 to DP, DM; see Figure 24	-	-	20	ns
t_{PHZ}	driver disable delay from HIGH level	TX_ENABLE to DP, DM; see Figure 25	-	-	12	ns
t_{PLZ}	driver disable delay from LOW level	TX_ENABLE to DP, DM; see Figure 25	-	-	12	ns
t_{PZH}	driver enable delay to HIGH level	TX_ENABLE to DP, DM; see Figure 25	-	-	20	ns
t_{PZL}	driver enable delay to LOW level	TX_ENABLE to DP, DM; see Figure 25	-	-	20	ns
Receiver timing						
Differential receiver						
$t_{PLH(rcv)}$	receiver propagation delay (LOW to HIGH)	DP, DM to RX_RCV, RX_DP, and RX_DM; see Figure 26	-	-	20	ns
$t_{PHL(rcv)}$	receiver propagation delay (HIGH to LOW)	DP, DM to RX_RCV, RX_DP, and RX_DM; see Figure 26	-	-	20	ns
Single-ended receiver						
$t_{PLH(se)}$	single-ended propagation delay (LOW to HIGH)	DP, DM to RX_RCV, RX_DP, and RX_DM; see Figure 26	-	-	20	ns
$t_{PHL(se)}$	single-ended propagation delay (HIGH to LOW)	DP, DM to RX_RCV, RX_DP, and RX_DM; see Figure 26	-	-	20	ns
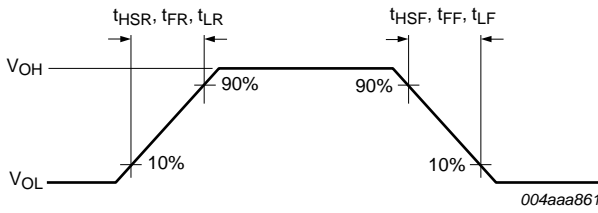
Fig 23.   Rise time and fall time
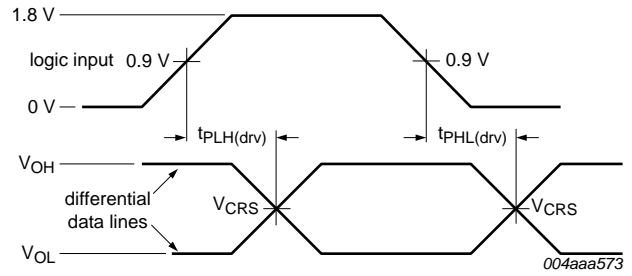
Fig 24.   Timing of TX_DAT and TX_SE0 to DP and DM
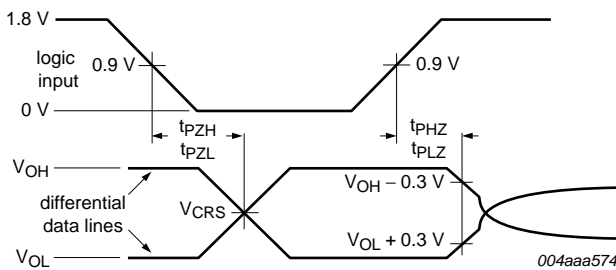
Fig 25.   Timing of TX_ENABLE to DP and DM
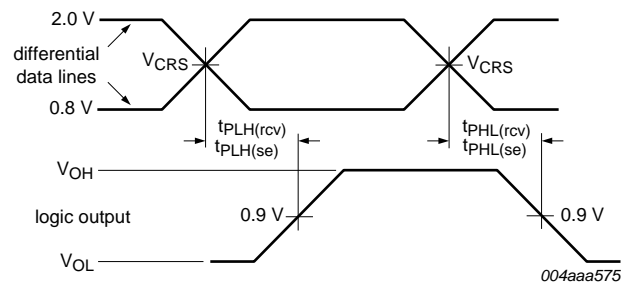
Fig 26.   Timing of DP and DM to RX_RCV, RX_DP, and RX_DM

16.1 ULPI timing

ULPI interface timing requirements are given in Figure 27. This timing applies to synchronous mode only. All timing is measured with respect to the ISP1507x1 CLOCK pin. All signals are clocked on the rising edge of CLOCK.
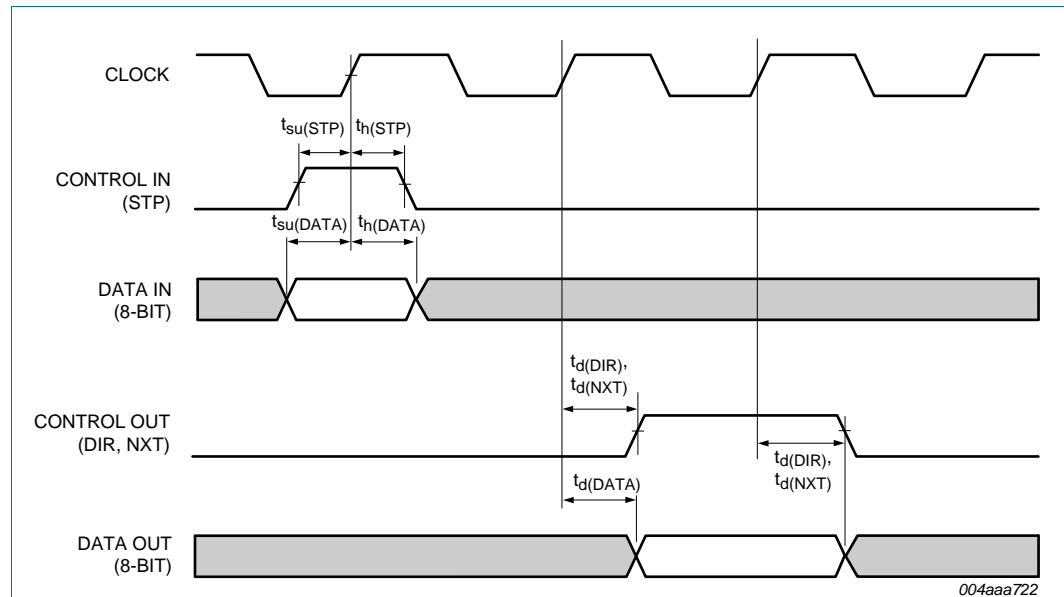
Fig 27.   ULPI interface timing

17. Application information

Table 58.   Recommended list of materials

Designator[1]	Application	Value	Comment
C_{bypass}	highly recommended for all applications	0.1 μF	-
C_{filter}	highly recommended for all applications	4.7 μF $\pm$ 20%; use a LOW ESR capacitor (0.2 Ω to 2 Ω) for best performance	-
C_{VBUS}	mandatory for peripherals	0.1 μF and 1 μF to 10 μF in parallel	-
	mandatory for host	0.1 μF and 120 μF $\pm$ 20% (min) in parallel	-
	mandatory for OTG	0.1 μF and 1 μF to 6.5 μF in parallel	-
R_{pullup}	recommended; for applications with an external V_{BUS} supply controlled by PSW_N	4.7 kΩ (recommended)	maximum value is determined by the voltage drop on PSW_N caused by leakage into PSW_N and the external supply control pin
R_{RREF}	mandatory in all applications	12 kΩ $\pm$ 1%	-
R_{VBUS}	strongly recommended for peripheral or external 5 V applications only	1 kΩ $\pm$ 5%	-
R_{XTAL}	required only for applications driving a square wave into the XTAL1 pin	47 kΩ $\pm$ 5%	used to avoid floating input on the XTAL1 pin
XTAL	crystal is used	19.2 MHz	C_L = 10 pF; R_S < 220 Ω; C_{XTAL} = 18 pF
		26 MHz	C_L = 10 pF; R_S < 130 Ω; C_{XTAL} = 18 pF
		CSTCE26M0XK2***-R0[2]	C_{XTAL} is not required
$C_{(XTAL)SQ}$	required only for applications driving a square wave into the XTAL1 pin that has a DC offset	100 pF	used to AC couple the input square wave to the XTAL1 pin

[1]   For detailed information and alternative interface options, refer to the *Interfacing to the ISP1507x1 (AN3173)* application note.

[2]   For more information, contact Murata.

Remark: The link controls CHIP_SELECT_N of the ISP1507x1 so that other ICs can utilize the interface pins when the ISP1507x1 is not selected.

ISP1507A1; ISP1507B1

ULPI HS USB OTG transceiver
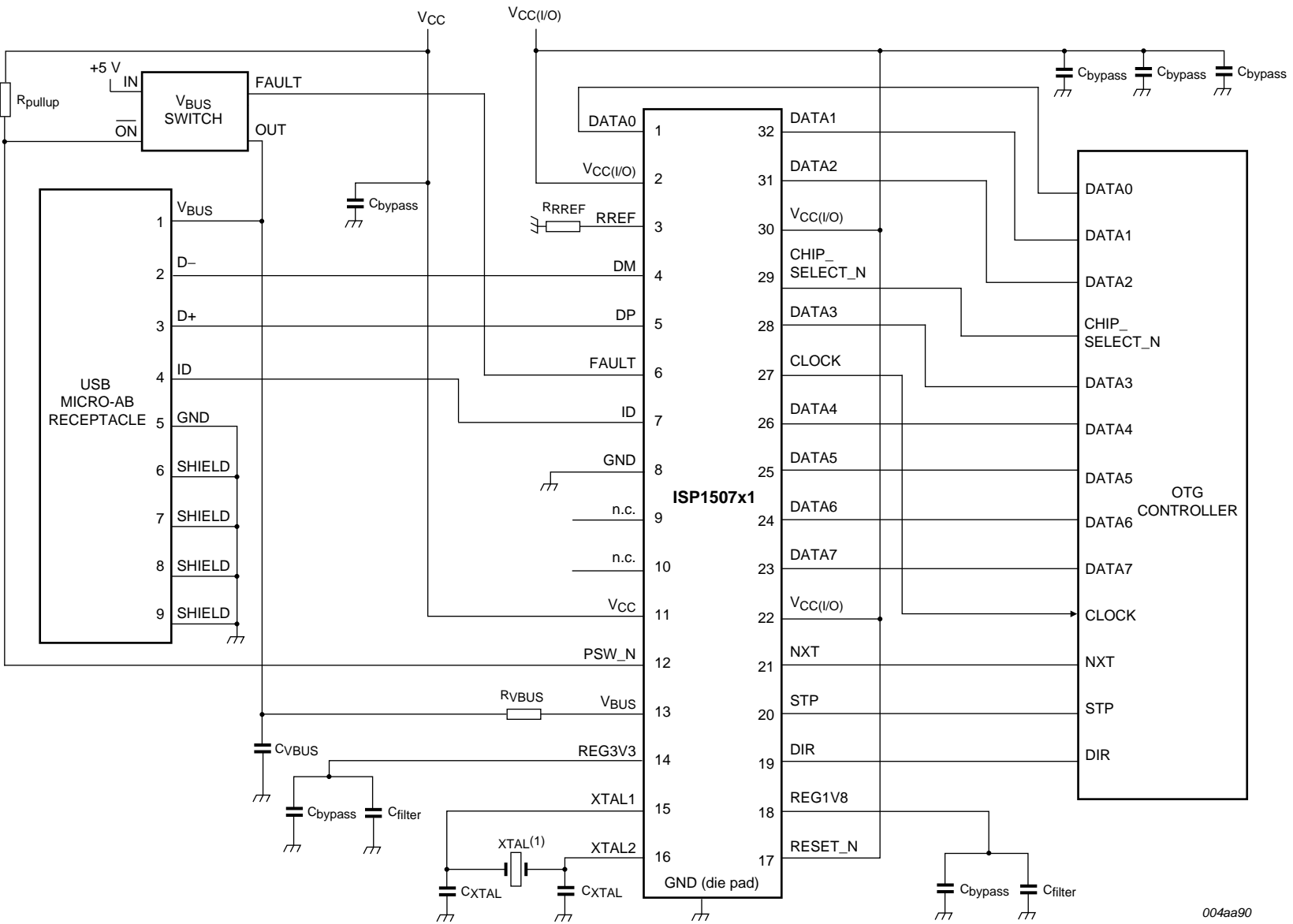
(1) Frequency is version dependent: ISP1507A1: 19.2 MHz; ISP1507B1: 26 MHz.

Fig 28.   Using the ISP1507x1 with an OTG controller; crystal is attached; external 5 V source with built-in FAULT

004aa90

ISP1507A1; ISP1507B1

ULPI HS USB OTG transceiver
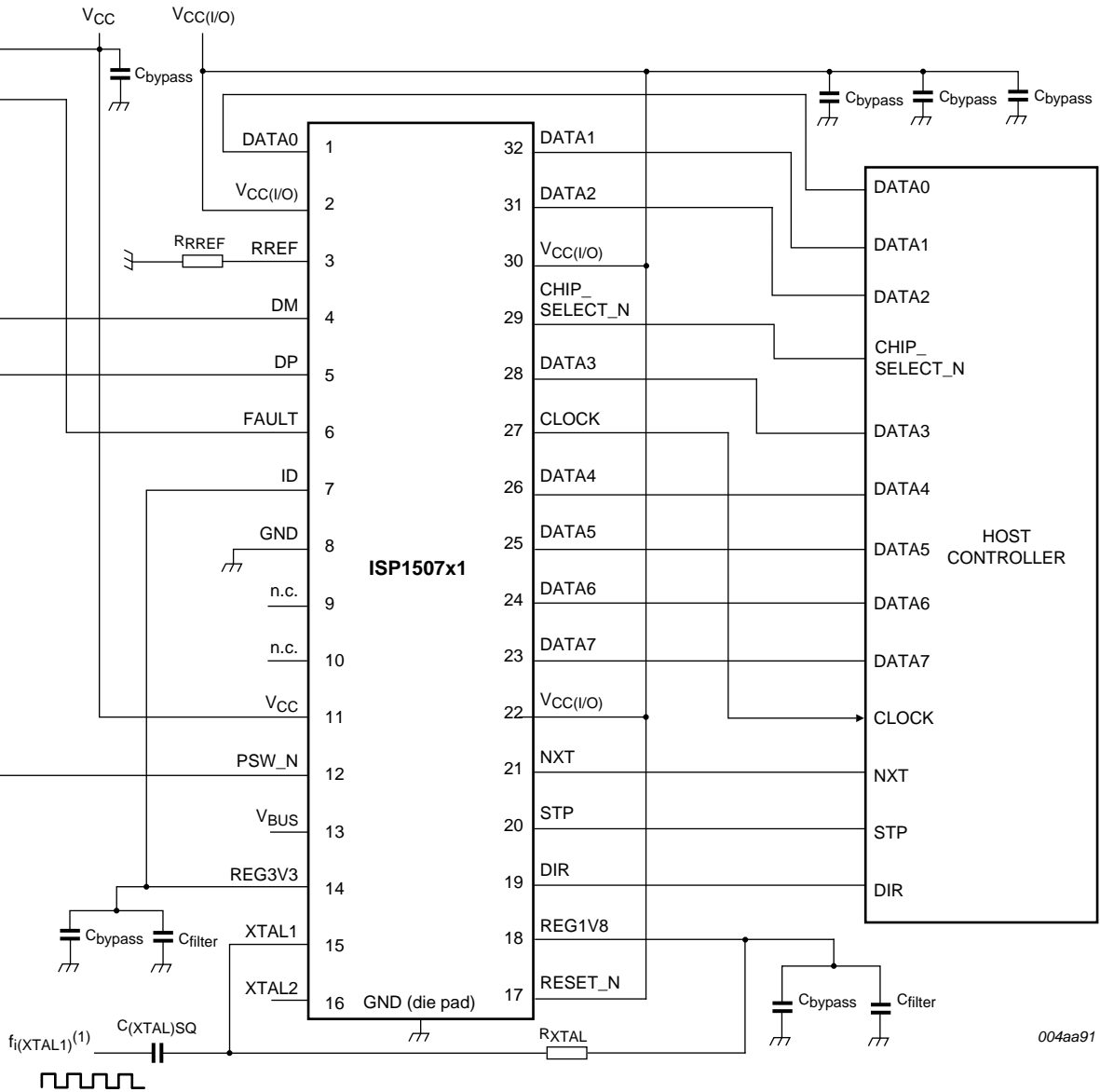
(1) Frequency is version dependent: ISP1507A1: 19.2 MHz; ISP1507B1: 26 MHz.

Fig 29.   Using the ISP1507x1 with a standard USB host controller; external 5 V source with built-in FAULT and external square wave input on XTAL1

ST ERICSSON

ISP1507A1; ISP1507B1

ULPI HS USB OTG transceiver

V_{CC} $V_{CC(I/O)}$

C_{bypass}

C_{bypass} C_{bypass} C_{bypass}

USB STANDARD-B RECEPTACLE

1	V_{BUS}	R_{VBUS}
2	D−	
3	D+	
4	GND	
5	SHIELD	
6	SHIELD	

ISP1507x1

DATA0	1	32	DATA1
$V_{CC(I/O)}$	2	31	DATA2
RREF	3	30	$V_{CC(I/O)}$
DM	4	29	CHIP_SELECT_N
DP	5	28	DATA3
FAULT	6	27	CLOCK
ID	7	26	DATA4
GND	8	25	DATA5
n.c.	9	24	DATA6
n.c.	10	23	DATA7
V_{CC}	11	22	$V_{CC(I/O)}$
PSW_N	12	21	NXT
V_{BUS}	13	20	STP
REG3V3	14	19	DIR
XTAL1	15	18	REG1V8
XTAL2	16	17	RESET_N
			GND (die pad)

R_{RREF}

PERIPHERAL CONTROLLER

| DATA0 |
| DATA1 |
| DATA2 |
| CHIP_SELECT_N |
| DATA3 |
| DATA4 |
| DATA5 |
| DATA6 |
| DATA7 |
| CLOCK |
| NXT |
| STP |
| DIR |

C_{VBUS}

C_{bypass} C_{filter}

XTAL(1)

C_{XTAL} C_{XTAL}

C_{bypass} C_{filter}

004aa92

(1) Frequency is version dependent: ISP1507A1: 19.2 MHz; ISP1507B1: 26 MHz.

Fig 30. Using the ISP1507x1 with a standard USB peripheral controller; external crystal

18. Package outline

HVQFN32: plastic thermal enhanced very thin quad flat package; no leads;
32 terminals; body 5 x 5 x 0.85 mm

SOT617-1

DIMENSIONS (mm are the original dimensions)

UNIT	A[1] max.	A₁	b	c	D[1]	Dₕ	E[1]	Eₕ	e	e₁	e₂	L	v	w	y	y₁
mm	1	0.05 0.00	0.30 0.18	0.2	5.1 4.9	3.25 2.95	5.1 4.9	3.25 2.95	0.5	3.5	3.5	0.5 0.3	0.1	0.05	0.05	0.1

Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT617-1	- - -	MO-220	- - -			~~01-08-08~~ 02-10-18
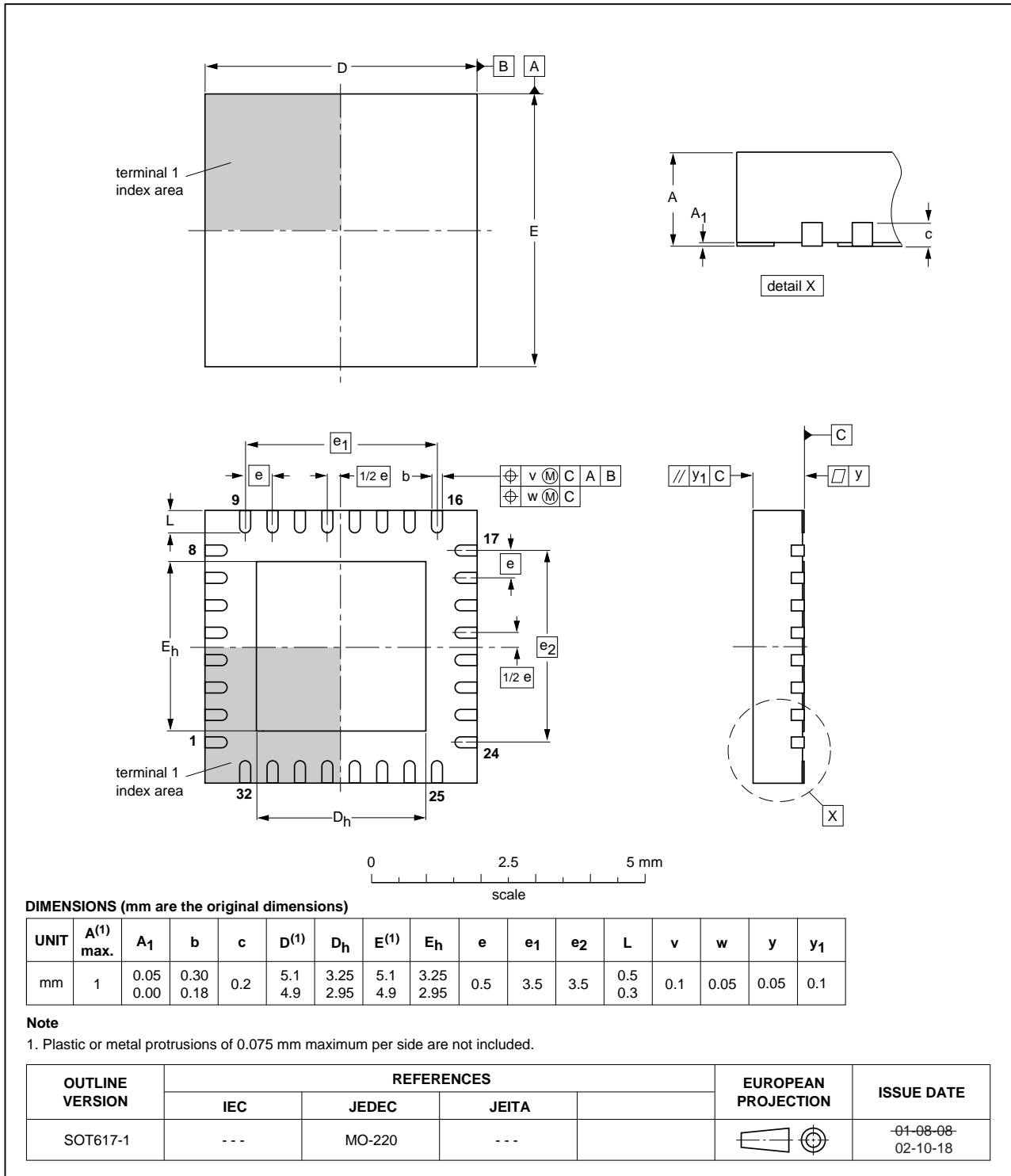
Fig 31. Package outline SOT617-1 (HVQFN32)

19. Abbreviations

Table 59.   Abbreviations

Acronym	Description
ASIC	Application-Specific Integrated Circuit
ATX	Analog USB Transceiver
CD-RW	Compact Disc-ReWritable
EOP	End-Of-Packet
ESD	ElectroStatic Discharge
ESR	Effective Series Resistance
FS	Full-Speed
HBM	Human Body Model
HNP	Host Negotiation Protocol
HS	High-Speed
ID	Identification
IEC	International Electrotechnical Commission
LS	Low-Speed
NRZI	Non-Return-to-Zero Inverted
OTG	On-The-Go
PCB	Printed-Circuit Board
PHY	Physical Layer[1]
PID	Packet Identifier
PLD	Programmable Logic Device
PLL	Phase-Locked Loop
POR	Power-On Reset
RXCMD	Receive Command
SE0	Single-Ended Zero
SOF	Start-Of-Frame
SRP	Session Request Protocol
SYNC	Synchronous
TTL	Transistor-Transistor Logic
TXCMD	Transmit Command
USB	Universal Serial Bus
USB-IF	USB Implementers Forum
ULPI	UTMI+ Low Pin Interface
UTMI	USB 2.0 Transceiver Macrocell Interface
UTMI+	USB 2.0 Transceiver Macrocell Interface Plus

[1]   Physical layer containing the USB transceiver. The ISP1507x1 is a PHY.

20. References

[1] Universal Serial Bus Specification Rev. 2.0

[2] On-The-Go Supplement to the USB 2.0 Specification Rev. 1.3

[3] UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1

[4] UTMI+ Specification Rev. 1.0

[5] USB 2.0 Transceiver Macrocell Interface (UTMI) Specification Ver. 1.05

[6] Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM) (JESD22-A114D)

[7] Interfacing to the ISP1507x1 (AN3173)

21. Revision history

Table 60. Revision history

Revision	Release date	Data sheet status	Change notice
3	20100726	Product data sheet	-
Modifications:	• Table 58 "Recommended list of materials": removed D_{VBUS}. • Figure 28 "Using the ISP1507x1 with an OTG controller; crystal is attached; external 5 V source with built-in FAULT": updated.		
2	20100601	Product data sheet	-
1	20100412	Product data sheet	-

22. Tables

23. Figures

24. Contents

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